Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

Send any inquiries to http://www.renesas.com/inquiry.

Notice

- 1. All information included in this document is current as of the date this document is issued. Such information, however, is subject to change without any prior notice. Before purchasing or using any Renesas Electronics products listed herein, please confirm the latest product information with a Renesas Electronics sales office. Also, please pay regular and careful attention to additional and different information to be disclosed by Renesas Electronics such as that disclosed through our website.
- Renesas Electronics does not assume any liability for infringement of patents, copyrights, or other intellectual property rights of third parties by or arising from the use of Renesas Electronics products or technical information described in this document. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
- 3. You should not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part.
- 4. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation of these circuits, software, and information in the design of your equipment. Renesas Electronics assumes no responsibility for any losses incurred by you or third parties arising from the use of these circuits, software, or information.
- 5. When exporting the products or technology described in this document, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations. You should not use Renesas Electronics products or the technology described in this document for any purpose relating to military applications or use by the military, including but not limited to the development of weapons of mass destruction. Renesas Electronics products and technology may not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations.
- 6. Renesas Electronics has used reasonable care in preparing the information included in this document, but Renesas Electronics does not warrant that such information is error free. Renesas Electronics assumes no liability whatsoever for any damages incurred by you resulting from errors in or omissions from the information included herein.
- 7. Renesas Electronics products are classified according to the following three quality grades: "Standard", "High Quality", and "Specific". The recommended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below. You must check the quality grade of each Renesas Electronics product before using it in a particular application. You may not use any Renesas Electronics product for any application categorized as "Specific" without the prior written consent of Renesas Electronics. Further, you may not use any Renesas Electronics. Renesas Electronics shall not be in any way liable for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for an application categorized as "Specific" or for which the product is not intended where you have failed to obtain the prior written consent of Renesas Electronics. The quality grade of each Renesas Electronics product is "Standard" unless otherwise expressly specified in a Renesas Electronics data sheets or data books, etc.
 - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots.
 - "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control systems; anti-disaster systems; anticrime systems; safety equipment; and medical equipment not specifically designed for life support.
 - "Specific": Aircraft; aerospace equipment; submersible repeaters; nuclear reactor control systems; medical equipment or systems for life support (e.g. artificial life support devices or systems), surgical implantations, or healthcare intervention (e.g. excision, etc.), and any other applications or purposes that pose a direct threat to human life.
- 8. You should use the Renesas Electronics products described in this document within the range specified by Renesas Electronics, especially with respect to the maximum rating, operating supply voltage range, movement power voltage range, heat radiation characteristics, installation and other product characteristics. Renesas Electronics shall have no liability for malfunctions or damages arising out of the use of Renesas Electronics products beyond such specified ranges.
- 9. Although Renesas Electronics endeavors to improve the quality and reliability of its products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please be sure to implement safety measures to guard them against the possibility of physical injury, and injury or damage caused by fire in the event of the failure of a Renesas Electronics product, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult, please evaluate the safety of the final products or system manufactured by you.
- 10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please use Renesas Electronics products in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. Renesas Electronics assumes no liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- 11. This document may not be reproduced or duplicated, in any form, in whole or in part, without prior written consent of Renesas Electronics.
- 12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products, or if you have any other inquiries.
- (Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majorityowned subsidiaries.
- (Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

RENESAS

R8C/22 Group, R8C/23 Group RENESAS MCU

1. Overview

This MCU is built using the high-performance silicon gate CMOS process using the R8C CPU core and is packaged in a 48-pin plastic molded LQFP. This MCU operates using sophisticated instructions featuring a high level of instruction efficiency. With 1 Mbyte of address space, it is capable of executing instructions at high speed. This MCU is equipped with one CAN module and suited to in-vehicle or FA networking.

Furthermore, the data flash (1 KB x 2 blocks) is embedded in the R8C/23 Group.

The difference between R8C/22 and R8C/23 Groups is only the existence of the data flash. Their peripheral functions are the same.

1.1 Applications

Automotive, etc.



1.2 Performance Overview

Table 1.1 outlines the Functions and Specifications for R8C/22 Group and Table 1.2 outlines the Functions and Specifications for R8C/23 Group.

	Item	Specification		
CPU	Number of fundamental instructions			
	Minimum instruction execution time	50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V)		
		100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)		
	Operating mode	Single-chip		
	Address space	1 Mbyte		
Deviational	Memory capacity	Refer to Table 1.3 Product Information for R8C/22 Group		
Peripheral Function	Ports	I/O ports: 41 pins, Input port: 3 pins		
Function	Timers	Timer RA: 8 bits x 1 channel, Timer RB: 8 bits x 1 channel		
		(Each timer equipped with 8-bit prescaler)		
		Timer RD: 16 bits x 2 channel		
		(Circuits of input capture and output compare)		
		Timer RE: With compare match function		
	Serial interface	1 channel (UART0)		
		Clock synchronous I/O, UART		
		1 channel (UART1)		
		UART		
	Clock synchronous serial interface	1 channel		
		I ² C bus interface ⁽²⁾ , Clock synchronous serial I/O with chip		
		select		
	LIN module	Hardware LIN: 1 channel		
		(timer RA, UART0)		
	CAN module	1 channel with 2.0B specification: 16 slots		
	A/D converter	10-bit A/D converter: 1 circuit, 12 channels		
	Watchdog timer	15 bits x 1 channel (with prescaler)		
		Reset start selectable		
	Interrupt	Internal: 14 sources, External: 6 sources, Software: 4 sources,		
		Priority level: 7 levels		
	Clock generation circuits	2 circuits		
		XIN clock generation circuit (with on-chip feedback resistor) On-chip oscillator (high speed, low speed)		
		High-speed on-chip oscillator has frequency adjustment		
		function.		
	Oscillation stop detection	Stop detection of XIN clock oscillation		
	function			
	Voltage detection circuit	On-chip		
	Power-on reset circuit include	On-chip		
Electric	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz)(D, J version)		
Characteristics		VCC = 3.0 to 5.5 V (f(XIN) = 16 MHz)(K version)		
		VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz)		
	Current consumption	Typ. 12.5 mA (VCC = 5 V, f(XIN) = 20 MHz, High-speed on-		
		chip oscillator stopping)		
		Typ. 6.0 mA (VCC = 5 V, f(XIN) = 10 MHz, High-speed on-chip		
		oscillator stopping)		
Flash Memory	Programming and erasure voltage	VCC = 2.7 to 5.5 V		
	Programming and erasure endurance	100 times		
Operating Ambi	ent Temperature	-40 to 85°C		
		-40 to 125°C (option ⁽¹⁾)		
Package		48-pin mold-plastic LQFP		

Table 1.1Functions and Specifications for R8C/22 Group

NOTES:

1. When using options, be sure to inquire about the specification.

2. I²C bus is a registered trademark of Koninklijke Philips Electronics N.V.

RENESAS

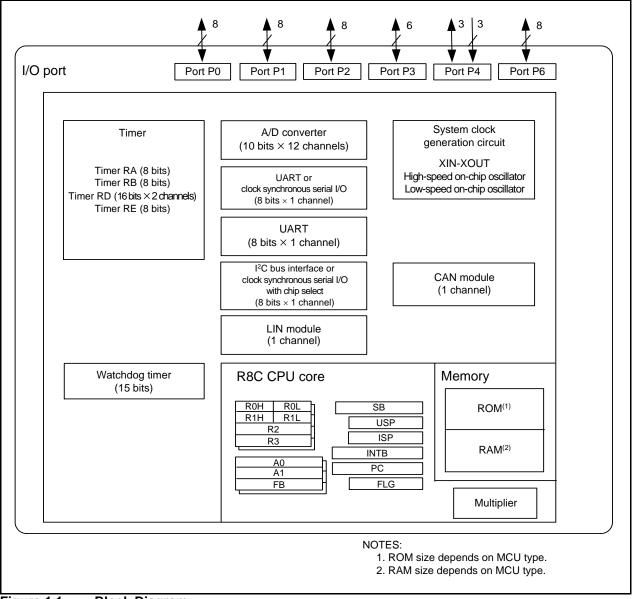
	Item	Specification		
CPU	Number of fundamental instructions			
	Minimum instruction execution time	50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V)		
		100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)		
	Operating mode	Single-chip		
	Address space	1 Mbyte		
	Memory capacity	Refer to Table 1.4 Product Information for R8C/23 Group		
Peripheral	Ports	I/O ports: 41 pins, Input port: 3 pins		
Function	Timers	Timer RA: 8 bits x 1 channel,		
		Timer RB: 8 bits x 1 channel		
		(Each timer equipped with 8-bit prescaler)		
		Timer RD: 16 bits x 2 channel		
		(Circuits of input capture and output compare)		
		Timer RE: With compare match function		
	Serial interface	1 channel (UART0)		
		Clock synchronous I/O, UART		
		1 channel (UART1)		
		UART		
	Clock synchronous serial interface	1 channel		
		I ² C bus interface ⁽²⁾ , Clock synchronous serial I/O with chip select		
	LIN module	Hardware LIN: 1 channel		
		(Timer RA, UART0)		
	CAN module	1 channel with 2.0B specification: 16 slots		
	A/D converter	10-bit A/D converter: 1 circuit, 12 channels		
	Watchdog timer	15 bits x 1 channel (with prescaler)		
		Reset start selectable		
	Interrupts	Internal: 14 sources, External: 6 sources, Software: 4 sources,		
		Priority level: 7 levels		
	Clock generation circuits	2 circuits		
		XIN clock generation circuit (with on-chip feedback resistor)		
		On-chip oscillator (high speed, low speed)		
		High-speed on-chip oscillator has frequency adjustmen		
		function.		
	Oscillation stop detection	Stop detection of XIN clock oscillation		
	Voltage detection circuit	On-chip		
	Power-on reset circuit include	On-chip		
Electric		VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz)(D, J version)		
Characteristics	Supply voltage	VCC = 3.0 to 5.5 V (I(XIN) = 20 MHZ)(D, J Version) VCC = 3.0 to 5.5 V (f(XIN) = 16 MHZ)(K version)		
Characteristics		VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz)		
	Current consumption	Typ. 12.5 mA (VCC = 5 V, $f(XIN) = 20$ MHz, High-speed on-		
		chip oscillator stopping)		
		Typ. 6.0 mA (VCC = 5 V, f(XIN) = 10 MHz, High-speed on-chip		
		oscillator stopping)		
Flash Memory	Programming and erasure voltage	VCC = 2.7 to 5.5 V		
	Programming and erasure	10,000 times (data flash)		
	endurance	1,000 times (program ROM)		
Operating Ambi	ent Temperature	-40 to 85°C		
Packaga		-40 to 125°C (option ⁽¹⁾) 48-pin mold-plastic LQFP		
Package		+0-pin molu-plastic LQFF		

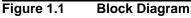
 Table 1.2
 Functions and Specifications for R8C/23 Group

- 1. When using options, be sure to inquire about the specification.
- 2. I²C bus is a registered trademark of Koninklijke Philips Electronics N.V.

1.3 Block Diagram

Figure 1.1 shows a Block Diagram.





RENESAS

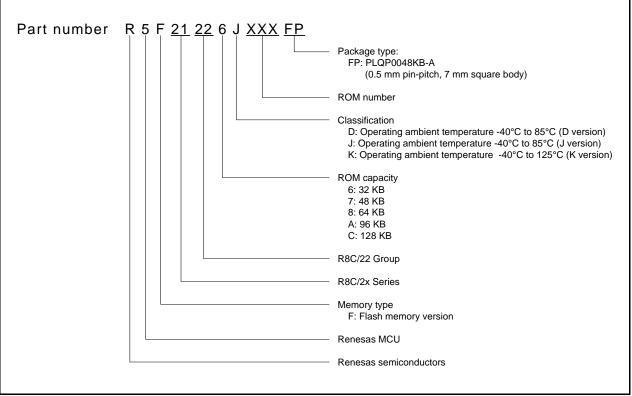
1.4 **Product Information**

Table 1.3 lists Product Information for R8C/22 Group and Table 1.4 lists Product Information for R8C/23 Group.

Table 1.3 Pro	Curr	ent of Aug. 2008			
Type No.	ROM Capacity	RAM Capacity	Package Type	Re	emarks
R5F21226DFP	32 Kbytes	2 Kbytes	PLQP0048KB-A	D version	Flash memory
R5F21227DFP	48 Kbytes	2.5 Kbytes	PLQP0048KB-A	1	version
R5F21228DFP	64 Kbytes	3 Kbytes	PLQP0048KB-A	1	
R5F21226JFP	32 Kbytes	2 Kbytes	PLQP0048KB-A	J version	
R5F21227JFP	48 Kbytes	2.5 Kbytes	PLQP0048KB-A	1	
R5F21228JFP	64 Kbytes	3 Kbytes	PLQP0048KB-A	1	
R5F2122AJFP	96 Kbytes	5 Kbytes	PLQP0048KB-A	1	
R5F2122CJFP	128 Kbytes ⁽¹⁾	6 Kbytes	PLQP0048KB-A		
R5F21226KFP	32 Kbytes	2 Kbytes	PLQP0048KB-A	K version	
R5F21227KFP	48 Kbytes	2.5 Kbytes	PLQP0048KB-A		
R5F21228KFP	64 Kbytes	3 Kbytes	PLQP0048KB-A	1	
R5F2122AKFP	96 Kbytes	5 Kbytes	PLQP0048KB-A	1	
R5F2122CKFP	128 Kbytes ⁽¹⁾	6 Kbytes	PLQP0048KB-A		

NOTE:

1. Do not use addresses 20000h to 23FFFh because these areas are used for the emulator debugger. Refer to 24. Notes on Emulator Debugger of Hardware Manual.





Type Number, Memory Size, and Package of R8C/22 Group



Type No.	ROM C	apacity	RAM Capacity	Package Type	Rem	arke
Type No.	Program ROM	Data Flash		Fackage Type	ITEIIIdIK5	
R5F21236DFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A	D version	Flash
R5F21237DFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		memory
R5F21238DFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A		version
R5F21236JFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A	J version	
R5F21237JFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		
R5F21238JFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A		
R5F2123AJFP	96 Kbytes	1 Kbyte X 2	5 Kbytes	PLQP0048KB-A		
R5F2123CJFP	128 Kbytes ⁽¹⁾	1 Kbyte X 2	6 Kbytes	PLQP0048KB-A		
R5F21236KFP	32 Kbytes	1 Kbyte X 2	2 Kbytes	PLQP0048KB-A	K version	
R5F21237KFP	48 Kbytes	1 Kbyte X 2	2.5 Kbytes	PLQP0048KB-A		
R5F21238KFP	64 Kbytes	1 Kbyte X 2	3 Kbytes	PLQP0048KB-A	1	
R5F2123AKFP	96 Kbytes	1 Kbyte X 2	5 Kbytes	PLQP0048KB-A	1	
R5F2123CKFP	128 Kbytes ⁽¹⁾	1 Kbyte X 2	6 Kbytes	PLQP0048KB-A		

Table 1.4 Product Information for R8C/23 Group

Current of Aug. 2008

NOTE:

1. Do not use addresses 20000h to 23FFFh because these areas are used for the emulator debugger. Refer to **24. Notes on Emulator Debugger** of Hardware Manual.

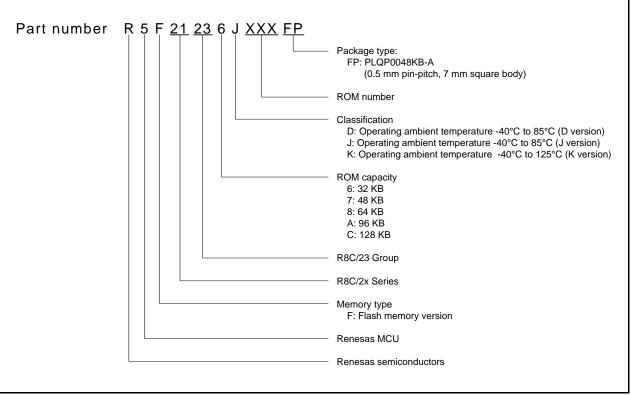


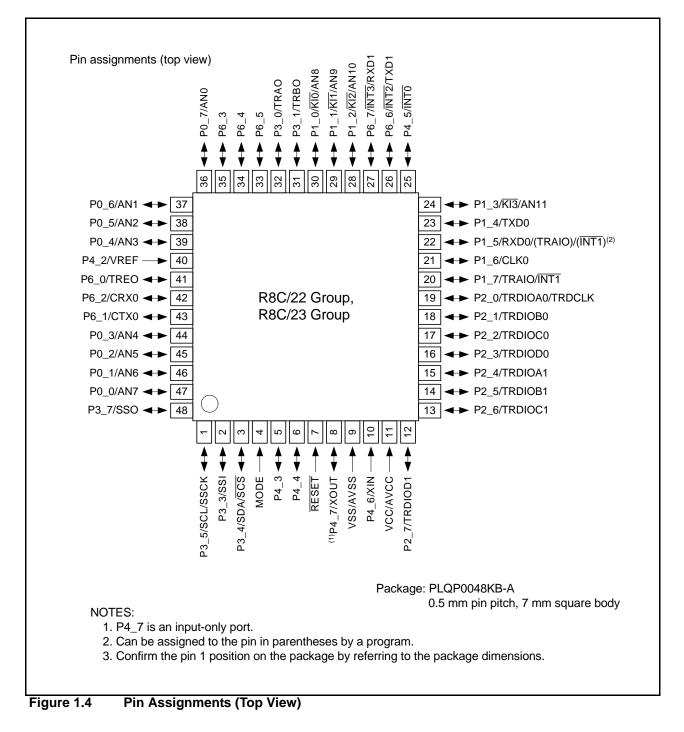
Figure 1.3

Type Number, Memory Size, and Package of R8C/23 Group



1.5 Pin Assignments

Figure 1.4 shows Pin Assignments (Top View).





1.6 **Pin Functions**

Table 1.5 lists the Pin Functions and Table 1.6 lists the Pin Name Information by Pin Number.

Туре	Symbol	I/O Type	Description
Power Supply Input	VCC VSS	1	Apply 2.7 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog Power Supply Input	AVCC, AVSS	I	Applies the power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
Reset Input	RESET	I	Input "L" on this pin resets the MCU.
MODE	MODE	1	Connect this pin to VCC via a resistor.
XIN Clock Input	XIN	1	These pins are provided for the XIN clock generation
XIN Clock Output	XOUT	0	circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins. To use an externally derived clock, input it to the XIN pin and leave the XOUT pin open.
INT Interrupt Input	INTO to INT3	Ι	INT interrupt input pins. INTO Timer RD input pins. INT1 Timer RA input pins.
Key Input Interrupt	KI0 to KI3	I	Key input interrupt input pins.
Timer RA	TRAIO	I/O	Timer RA I/O pin.
	TRAO	0	Timer RA output pin.
Timer RB	TRBO	0	Timer RB output pin.
Timer RD	TRDIOA0, TRDIOA1, TRDIOB0, TRDIOB1, TRDIOC0, TRDIOC1, TRDIOD0, TRDIOD1	I/O	Timer RD I/O ports.
	TRDCLK	I	External clock input pin.
Timer RE	TREO	0	Divided clock output pin.
Serial Interface	CLK0	I/O	Transfer clock I/O pin.
	RXD0, RXD1	I	Serial data input pins.
	TXD0, TXD1	0	Serial data output pins.
I ² C Bus Interface	SCL	I/O	Clock I/O pin.
	SDA	I/O	Data I/O pin.
Clock Synchronous	SSI	I/O	Data I/O pin.
Serial I/O with Chip	SCS	I/O	Chip-select signal I/O pin.
Select	SSCK	I/O	Clock I/O pin.
	SSO	I/O	Data I/O pin.
CAN Module	CRX0	I	CAN data input pin.
	CTX0	0	CAN data output pin.
Reference Voltage Input	VREF	I	Reference voltage input pin to A/D converter.
A/D Converter	AN0 to AN11	I	Analog input pins to A/D converter.
I/O Port	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0, P3_1, P3_3 to P3_5, P3_7,	I/O	CMOS I/O ports. Each port contains an input/output select direction register, allowing each pin in that port to be directed for input or output individually. Any port set to input can select whether to use a pull-up resistor or not by a program.

Table 1.5 **Pin Functions**

P4_2, P4_6, P4_7 Input Port I I: Input O: Output I/O: Input and output

P4_3 to P4_5, P6_0 to P6_7



Input only ports.

Table 1.		amem	iomatio	n by Pin Numbe	I				
				I/O Pin	Functions	for of Periphera	I Modules		
Pin Number	Control Pin	Port	Interrupt	Timer	Serial Interface	Clock Synchronous Serial I/O with	I ² C Bus Interface	CAN Module	A/D Converter
						Chip Select	menace		5001
1		P3_5				SSCK	SCL		
2		P3_3				SSI			
3		P3_4				SCS	SDA		
4	MODE								
5		P4_3							
6		P4_4							
7	RESET								
8	XOUT	P4_7							
9	VSS/AVSS								
10	XIN	P4_6							
11	VCC/AVCC								
12		P2_7		TRDIOD1					
13		P2_6		TRDIOC1					
14		P2_5		TRDIOB1					
15		P2_4		TRDIOA1					
16		P2_3		TRDIOD0					
17		P2_2		TRDIOC0					
18		P2_1		TRDIOB0					
19 20		P2_0 P1_7		TRDIOA0/TRDCLK TRAIO					
			INT1	TRAIO	01.1/0				
21		P1_6	()		CLK0				
22		P1_5	(INT1) ⁽¹⁾	(TRAIO) ⁽¹⁾	RXD0				
23		P1_4			TXD0				
24		P1_3	KI3						AN11
25		P4_5	INT0	INTO					
26		P6_6	INT2		TXD1				
27		P6_7	INT3		RXD1				
28		P1_2	KI2						AN10
29		P1_1	KI1						AN9
30		P1_0	KIO						AN8
31		P3_1	NIU	TRBO					,
31		P3_0		TRAO					├
33		P6_5							
34		P6_4							
35		P6_3		 					
36		P0_7							AN0
37		P0_6							AN1
38									AN2
39		P0_4							AN3
40	VREF	P4_2							
41		P6_0		TREO					
42		P6_2						CRX0	
43		P6_1						CTX0	
44		P0_3							AN4
45		P0_2							AN5
46		P0_1							AN6

Table 1.6 Pin Name Information by Pin Number

48

47

NOTE: 1. Can be assigned to the pin in parentheses by a program.

P0_0

P3_7

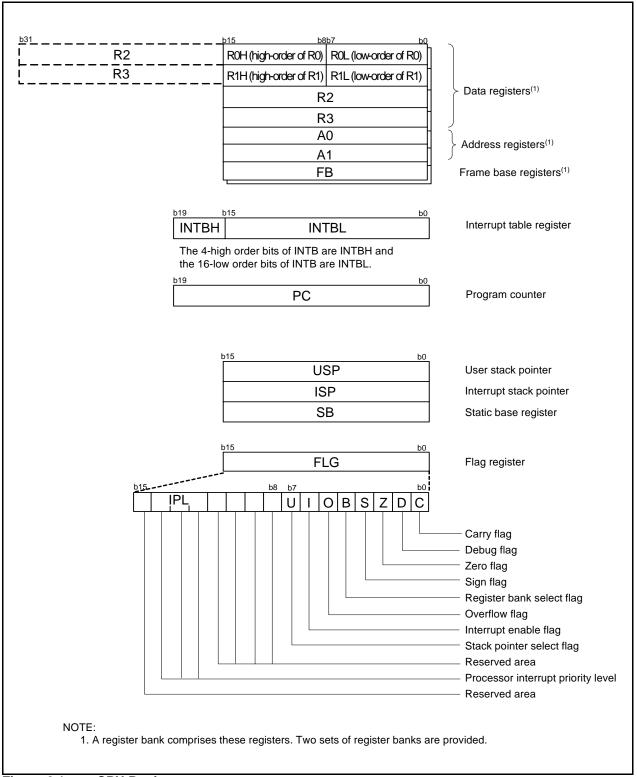
AN7

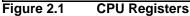


SSO

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. Of these, R0, R1, R2, R3, A0, A1, and FB comprise a register bank. Two sets of register banks are provided.





RENESAS

2.1 Data Registers (R0, R1, R2 and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3. R0 can be split into high-order bit (R0H) and low-order bit (R0L) to be used separately as 8-bit data registers. The same applies to R1H and R1L as R0H and R0L. R2 can be combined with R0 to be used as a 32-bit data register (R2R0). The same applies R3R1 as R2R0.

2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. They also are used for transfer, arithmetic and logic operations. The same applies to A1 as A0. A1 can be combined with A0 to be used a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB, a 20-bit register, indicates the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC, 20 bits wide, indicates the address of an instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointer (SP), USP and ISP, are 16 bits wide each. The U flag of FLG is used to switch between USP and ISP.

2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

2.8 Flag Register (FLG)

FLG is a 11-bit register indicating the CPU status.

2.8.1 Carry Flag (C)

The C flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic and logic unit.

2.8.2 Debug Flag (D)

The D flag is for debug only. Set to 0.

2.8.3 Zero Flag (Z)

The Z flag is set to 1 when an arithmetic operation resulted in 0; otherwise, 0.

2.8.4 Sign Flag (S)

The S flag is set to 1 when an arithmetic operation resulted in a negative value; otherwise, 0.

2.8.5 Register Bank Select Flag (B)

The register bank 0 is selected when the B flag is 0. The register bank 1 is selected when this flag is set to 1.

2.8.6 Overflow Flag (O)

The O flag is set to 1 when the operation resulted in an overflow; otherwise, 0.



2.8.7 Interrupt Enable Flag (I)

The I flag enables a maskable interrupt.

An interrupt is disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1. The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers. 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL, 3 bits wide, assigns processor interrupt priority levels from level 0 to level 7. If a requested interrupt has greater priority than IPL, the interrupt is enabled.

2.8.10 Reserved Bit

If necessary, set to 0. When read, the content is undefined.



3. Memory

3.1 R8C/22 Group

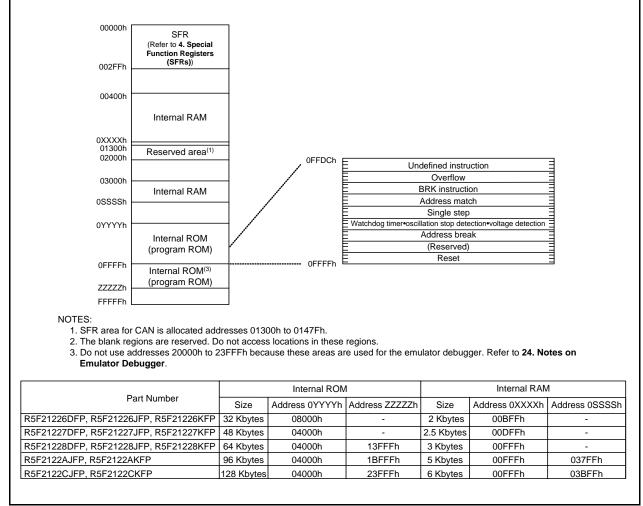
Figure 3.1 shows a Memory Map of R8C/22 Group. The R8C/22 Group has 1 Mbyte of address space from address 00000h to FFFFFh.

The internal ROM is allocated lower addresses, beginning with address 0FFFFh. For example, a 48-Kbyte internal ROM is allocated addresses 04000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 2.5-Kbyte internal RAM is allocated addresses 00400h to 00DFFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFR) are allocated addresses 00000h to 002FFh and 01300h to 0147Fh (SFR area for CAN). The peripheral function control registers are allocated here. All addresses within the SFR, which have nothing allocated are reserved for future user and cannot be accessed by users.







3.2 R8C/23 Group

Figure 3.2 shows a Memory Map of R8C/23 Group. The R8C/23 Group has 1 Mbyte of address space from address 00000h to FFFFh.

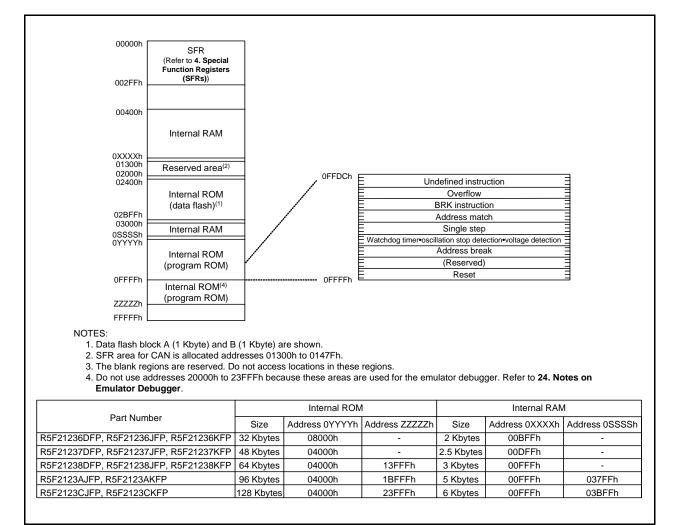
The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 48-Kbyte internal ROM is allocated addresses 04000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal ROM (data flash) is allocated addresses 02400h to 02BFFh.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 2.5-Kbyte internal RAM is allocated addresses 00400h to 00DFFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFR) are allocated addresses 00000h to 002FFh and 01300h to 0147Fh (SFR area for CAN). The peripheral function control registers are allocated them. All addresses within the SFR, which have nothing allocated are reserved for future use and cannot be accessed by users.





Memory Map of R8C/23 Group

RENESAS

4. Special Function Registers (SFRs)

An SFR (special function register) is a control register for a peripheral function. Table 4.1 to Table 4.13 list the SFR Information.

Table 4.1	SFR Information (1) ⁽¹⁾
-----------	------------------------------------

Address	Register	Symbol	After reset
0000h			
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PM0	00h
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	01101000b
0007h	System Clock Control Register 1	CM1	0010000b
0008h			
0009h			
000Ah	Protect Register	PRCR	00h
000Bh			
000Ch	Oscillation Stop Detection Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTS	XXh
000Fh	Watchdog Timer Control Register	WDC	00X11111b
0010h	Address Match Interrupt Register 0	RMAD0	00h
0011h			00h
0012h			00h
0013h	Address Match Interrupt Enable Register	AIER	00h
0014h	Address Match Interrupt Register 1	RMAD1	00h
0015h			00h
0016h			00h
0017h			
0018h			
0019h			
001Ah			
001Bh			
001Ch	Count Source Protect Mode Register	CSPR	00h
			1000000b ⁽⁸⁾
001Dh			
001Eh			
001Fh			
0020h			
0021h			
0022h			
0023h	High-Speed On-Chip Oscillator Control Register 0	FRA0	00h
0024h	High-Speed On-Chip Oscillator Control Register 1	FRA1	When shipping
0025h	High-Speed On-Chip Oscillator Control Register 2	FRA2	00h
0026h			

0030h			
0031h	Voltage Detection Register 1 ⁽²⁾	VCA1	00001000b
0032h	Voltage Detection Register 2 ⁽⁶⁾	VCA2	00h ⁽³⁾
			0100000b ⁽⁴⁾
0033h			
0034h			
0035h			
0036h	Voltage Monitor 1 Circuit Control Register ⁽⁷⁾	VW1C	0000X000b ⁽³⁾
			0100X001b ⁽⁴⁾
0037h	Voltage Monitor 2 Circuit Control Register ⁽⁵⁾	VW2C	00h
0038h			
0039h			
		I	•
003Fh			

003FI1

X: Undefined

NOTES:

- 1. The blank regions are reserved. Do not access locations in these regions.
- 2. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect this register.
- 3. The LVD0ON bit in the OFS register is set to 1.
- 4. Power-on reset, voltage monitor 1 reset or the LVD0ON bit in the OFS register is set to 0.
- 5. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect b2 and b3.
- 6. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect b7.
- 7. Software reset, the watchdog timer rest, and the voltage monitor 2 reset do not affect other than the b0 and b6.
- 8. The CSPROINI bit in the OFS register is 0.



SFR Information (2)⁽¹⁾ Table 4.2

Address	Register	Symbol	After reset
0040h			
0041h			
0042h			
0043h	CAN0 Wake Up Interrupt Control Register	C01WKIC	XXXXX000b
0044h	CAN0 Successful Reception Interrupt Control Register	CORECIC	XXXXX000b
0045h	CAN0 Successful Transmission Interrupt Control Register	COTRMIC	XXXXX000b
0046h	CAN0 State/Error Interrupt Control Register	C01ERRIC	XXXXX000b
0047h			
0048h	Timer RD0 Interrupt Control Register	TRD0IC	XXXXX000b
0049h	Timer RD1 Interrupt Control Register	TRD1IC	XXXXX000b
004Ah	Timer RE Interrupt Control Register	TREIC	XXXXX000b
004Bh			
004Ch			
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004Fh	SSU Interrupt Control Register/IIC Bus Interrupt Control Register ⁽²⁾	SSUIC/IICIC	XXXXX000b
0050h			
0051h	UART0 Transmit Interrupt Control Register	SOTIC	XXXXX000b
0052h	UARTO Receive Interrupt Control Register	SORIC	XXXXX000b
0053h	UART1 Transmit Interrupt Control Register	S1TIC	XXXXX000b
0054h	UART1 Receive Interrupt Control Register	S1RIC	XXXXX000b
0055h	INT2 Interrupt Control Register	INT2IC	XX00X000b
0056h	Timer RA Interrupt Control Register	TRAIC	XXXXX000b
0050h			10000000
0057h	Timer RB Interrupt Control Register	TRBIC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005An		INTSIC	22002000D
005Bh			
005Dh	INTO Interrupt Control Degister	INTOIC	XX00X000h
005Dh	INT0 Interrupt Control Register	INTOIC	XX00X000b
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah			
006Bh			
006Ch			
006Dh			
006Eh			
006Fh			
0070h			
0071h			
0072h			
0073h			
0074h			
0075h			
0076h			
0077h			
0078h			
0079h			
007Ah			
007Bh			
007Ch			
007Dh			
007Eh			
007Eh			
001111			

X: Undefined

NOTES:

The blank regions are reserved. Do not access locations in these regions.
 Selected by the IICSEL bit in the PMR register.



Address	Register	Symbol	After reset
0080h	5		
0081h			
0082h			
0083h			
0084h			
0085h			
0086h			
0087h			
0088h			
0089h			
008Ah			
008Bh			
008Ch			
008Dh			
008Eh			
008Fh			
0090h			
0091h			
0092h			
0093h			
0094h			
0094h			
0096h			
0097h			
0098h			
0099h			
009Ah			
009Bh			
009Ch			
009Dh			
009Eh			
009Fh			
00A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
00/10h	UARTO Bit Rate Register	U0BRG	XXh
00A2h	UART0 Transmit Buffer Register	UOTB	XXh
00/12h		0015	XXh
00/(0h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
00A5h	UARTO Transmit/Receive Control Register 1	U0C1	00000010b
00A6h	UARTO Receive Buffer Register	UORB	XXh
00A7h		COLE	XXh
00A8h	UART1 Transmit/Receive Mode Register	U1MR	00h
00A9h	UART1 Bit Rate Register	U1BRG	XXh
00AAh	UART1 Transmit Buffer Register	U1TB	XXh
00AAn 00ABh	of a criminal management of the second		XXh
00ABh 00ACh	UART1 Transmit/Receive Control Register 0	U1C0	00001000b
00ACh 00ADh	UART1 Transmit/Receive Control Register 0	U1C1	00001000b
00ADh 00AEh	UART1 Receive Buffer Register	U1RB	XXh
00AEn 00AFh	CARTE RECEIVE DUILEI REGISIEI		XXh
00AFn 00B0h			
00B0h			
00B1h			
00B2h 00B3h			
00B4h			
00B5h			
00B6h			
00B7h			006
00B8h	SS Control Register H/IIC Bus Control Register 1 ⁽²⁾	SSCRH/ICCR1	00h
00B9h	SS Control Register L/IIC Bus Control Register 2 ⁽²⁾	SSCRL/ICCR2	01111101b
00BAh	SS Mode Register/IIC Bus Mode Register 1 ⁽²⁾	SSMR/ICMR	00011000b
	SS Enable Register/IIC Bus Interrupt Enable Register ⁽²⁾	SSER/ICIER	00h
00BBh			
00BBh 00BCh		SSSR/ICSR	00h/0000X000b
	SS Status Register/IIC Bus Status Register ⁽²⁾	SSSR/ICSR SSMR2/SAR	00h/0000X000b 00h
00BCh			

SFR Information (3)⁽¹⁾ Table 4.3

X: Undefined

NOTES:

The blank regions are reserved. Do not access locations in these regions.
 Selected by the IICSEL bit in the PMR register.

RENESAS

			A.C
Address	Register	Symbol	After reset
00C0h	A/D Register	AD	XXh
00C1h			XXh
00C2h			
00C3h			
00C4h			
00C5h			
00C6h			
00C7h			
00C8h			
00C9h			
00CAh			
00CBh			
00CCh			
00CDh			
00CEh			
00CFh			
00D0h			
00D1h			
00D2h			
00D3h			
00D4h	A/D Control Register 2	ADCON2	00h
00D4h		n boonz	
00D5h	A/D Control Register 0	ADCON0	00h
00D6h	A/D Control Register 1	ADCON0	00h
00D7h 00D8h		ADCONT	
00D8h			
00D9n 00DAh			
00DAn 00DBh			
00DCh			
00DDh			
00DEh			
00DFh			
00E0h	Port P0 Register	P0	XXh
00E1h	Port P1 Register	P1	XXh
00E2h	Port P0 Direction Register	PD0	00h
00E3h	Port P1 Direction Register	PD1	00h
00E4h	Port P2 Register	P2	XXh
00E5h	Port P3 Register	P3	XXh
00E6h	Port P2 Direction Register	PD2	00h
00E7h	Port P3 Direction Register	PD3	00h
00E8h	Port P4 Register	P4	XXh
00E9h			
00EAh	Port P4 Direction Register	PD4	00h
00EBh	Ŭ Ŭ		- I
00ECh	Port P6 Register	P6	XXh
00EDh			
00EEh	Port P6 Direction Register	PD6	00h
00EFh			
00F0h			
00F1h			
00F1h			
00F2h			
00F3h			
	LIADT1 Eurotion Select Periotor		X Y h
00F5h 00F6h	UART1 Function Select Register	U1SR	XXh
00F6h 00F7h			
UUF/N	Dest Made Desister		
0050		PMR	00h
00F8h	Port Mode Register		
00F8h 00F9h	External Input Enable Register	INTEN	00h
00F8h 00F9h 00FAh	External Input Enable Register INT Input Filter Select Register	INTF	00h
00F8h 00F9h 00FAh 00FBh	External Input Enable Register INT Input Filter Select Register Key Input Enable Register	INTF KIEN	00h 00h
00F8h 00F9h 00FAh 00FBh 00FCh	External Input Enable Register INT Input Filter Select Register Key Input Enable Register Pull-Up Control Register 0	INTF KIEN PUR0	00h 00h 00h
00F8h 00F9h 00FAh 00FBh 00FCh 00FDh	External Input Enable Register INT Input Filter Select Register Key Input Enable Register	INTF KIEN	00h 00h
00F8h 00F9h 00FAh 00FBh 00FCh	External Input Enable Register INT Input Filter Select Register Key Input Enable Register Pull-Up Control Register 0	INTF KIEN PUR0	00h 00h 00h

Table 4.4SFR Information (4)(1)

X: Undefined

NOTE:



	(-)		
Address	Register	Symbol	After reset
0100h	Timer RA Control Register	TRACR	00h
0101h	Timer RA I/O Control Register	TRAIOC	00h
0102h	Timer RA Mode Register	TRAMR	00h
0103h	Timer RA Prescaler Register	TRAPRE	FFh
0104h	Timer RA Register	TRA	FFh
0105h		1107	
0106h	LIN Control Register	LINCR	00h
0107h	LIN Status Register	LINST	00h
0108h	Timer RB Control Register	TRBCR	00h
0109h	Timer RB One-Shot Control Register	TRBOCR	00h
010Ah	Timer RB I/O Control Register	TRBIOC	00h
010Bh	Timer RB Mode Register	TRBMR	00h
010Ch	Timer RB Prescaler Register	TRBPRE	FFh
010Dh	Timer RB Secondary Register	TRBSC	FFh
010Eh	Timer RB Primary	TRBPR	FFh
010Fh			
0110h			
0111h			
0112h			
0113h			
0114h			
0115h			
0116h			
0117h			
0118h	Timer RE Counter Data Register	TRESEC	00h
0119h	Timer RE Compare Data Register	TREMIN	00h
011Ah			
011Bh			
011Ch	Timer RE Control Register 1	TRECR1	00h
011Dh	Timer RE Control Register 2	TRECR2	00h
011Eh	Timer RE Count Source Select Register	TRECSR	00001000b
		TRECOR	000010000
011Fh			
0120h			
0121h			
0122h			
0123h			
0124h			
0125h			
0126h			
0127h			
0128h			
0129h			
0123h			
012Bh			
012Ch			
012Dh			
012Eh			
012Fh			
0130h			
0131h			
0132h			
0133h			
0133h 0134h			
0134h			
0134h 0135h			
0134h 0135h 0136h	Timer PD Start Register	TDIOCTD	11111100b
0134h 0135h 0136h 0137h	Timer RD Start Register	TRDSTR	11111100b
0134h 0135h 0136h 0137h 0138h	Timer RD Mode Register	TRDMR	00001110b
0134h 0135h 0136h 0137h 0138h 0139h	Timer RD Mode Register Timer RD PWM Mode Register	TRDMR TRDPMR	00001110b 10001000b
0134h 0135h 0136h 0137h 0138h 0139h 0139h	Timer RD Mode Register Timer RD PWM Mode Register Timer RD Function Control Register	TRDMR TRDPMR TRDFCR	00001110b 10001000b 10000000b
0134h 0135h 0136h 0137h 0138h 0139h 013Ah 013Bh	Timer RD Mode Register Timer RD PWM Mode Register Timer RD Function Control Register Timer RD Output Master Enable Register 1	TRDMR TRDPMR TRDFCR TRDOER1	00001110b 10001000b 10000000b FFh
0134h 0135h 0136h 0137h 0138h 0139h 013Ah 013Bh 013Ch	Timer RD Mode Register Timer RD PWM Mode Register Timer RD Function Control Register Timer RD Output Master Enable Register 1 Timer RD Output Master Enable Register 2	TRDMR TRDPMR TRDFCR TRDOER1 TRDOER2	00001110b 10001000b 10000000b FFh 01111111b
0134h 0135h 0136h 0137h 0138h 0139h 013Ah 013Bh	Timer RD Mode Register Timer RD PWM Mode Register Timer RD Function Control Register Timer RD Output Master Enable Register 1	TRDMR TRDPMR TRDFCR TRDOER1	00001110b 10001000b 10000000b FFh
0134h 0135h 0136h 0137h 0138h 0139h 013Ah 013Bh 013Ch	Timer RD Mode Register Timer RD PWM Mode Register Timer RD Function Control Register Timer RD Output Master Enable Register 1 Timer RD Output Master Enable Register 2	TRDMR TRDPMR TRDFCR TRDOER1 TRDOER2	00001110b 10001000b 10000000b FFh 01111111b

Table 4.5SFR Information (5)(1)

X: Undefined

NOTE:



Table 4.6	SFR Information	(6) ⁽¹⁾
-----------	-----------------	----------------------------

			A 41
Address	Register	Symbol	After reset
0140h	Timer RD Control Register 0	TRDCR0	00h
0141h	Timer RD I/O Control Register A0	TRDIORA0	10001000b
0142h	Timer RD I/O Control Register C0	TRDIORC0	10001000b
0143h	Timer RD Status Register 0	TRDSR0	11100000b
0144h	Timer RD Interrupt Enable Register 0	TRDIER0	11100000b
0145h	Timer RD PWM Mode Output Level Control Register 0	TRDPOCR0	11111000b
0146h	Timer RD Counter 0	TRD0	00h
0147h			00h
0148h	Timer RD General Register A0	TRDGRA0	FFh
0149h			FFh
014Ah	Timer RD General Register B0	TRDGRB0	FFh
014Bh			FFh
014Ch	Timer RD General Register C0	TRDGRC0	FFh
014Dh			FFh
014Eh	Timer RD General Register D0	TRDGRD0	FFh
014Fh			FFh
0150h	Timer RD Control Register 1	TRDCR1	00h
0151h	Timer RD I/O Control Register A1	TRDIORA1	10001000b
0152h	Timer RD I/O Control Register C1	TRDIORC1	10001000b
0153h	Timer RD Status Register 1	TRDSR1	1100000b
0154h	Timer RD Interrupt Enable Register 1	TRDIER1	11100000b
0155h	Timer RD PWM Mode Output Level Control Register 1	TRDPOCR1	11111000b
0156h	Timer RD Counter 1	TRD1	00h
0157h			00h
0157h	Timer RD General Register A1	TRDGRA1	FFh
0158h		INDORAT	FFh
015Ah	Timer RD General Register B1	TRDGRB1	FFh
015An		TRUGRET	FFh
015Dh	Timer RD General Register C1	TRDGRC1	FFh
015Ch	Timer RD General Register CT	TRUGRCT	FFh
015Dh	Timer DD Ceneral Degister D1	TRDCBD1	FFh
	Timer RD General Register D1	TRDGRD1	
015Fh			FFh
0160h			
0161h			
0162h			
0163h			
0164h			
0165h			
0166h			
0167h			
0168h			
0169h			
016Ah			
016Bh			
016Ch			
016Dh			
016Eh			
016Fh			
0170h			
0171h			
0172h			
0173h			
0174h			
0175h			
0176h			
0177h			
0178h			
0179h			
017Ah			
017Bh			
017Ch			
017Dh			
017Eh			
017En			

X: Undefined NOTE:



Address	Register	Symbol	After reset
0180h		-	
0181h			
0182h			
0183h			
0184h			
0185h			
0186h			
0187h			
0188h			
0189h			
018Ah			
018Bh			
018Ch			
018Dh			
018Eh			
018Fh			
0190h			
0191h			
0192h			
0193h			
0194h			
0195h			
0196h			
0197h			
0198h			
0199h			
0193h			
019Bh			
019Ch			
019Dh			
019Eh			
019Fh			
01A0h			
01A1h			
01A2h			
01A3h			
01A4h			
014411			
01A5h			
01A6h			
01A7h			
01A8h			
01A9h			
01AAh			
01ABh			
01ACh			1
01ADh			
01AEh			1
			l
01AFh			
01B0h			
01B1h			
01B2h			
01B3h	Flash Memory Control Register 4	FMR4	0100000b
01B4h			
01B5h	Flash Memory Control Register 1	FMR1	100000Xb
01B6h	, č		1
01B7h	Flash Memory Control Register 0	FMR0	0000001b
01B8h			00000010
01001			
01B9h			
01BAh			
01BBh			
01FDh			1
01FEh			
01FFh			
V	1		1

Table 4.7SFR Information (7)⁽¹⁾

X: Undefined

NOTE:



Table 4.8SFR Information (8)(1)

Address	Register	Symbol	After reset
1300h	CAN0 Message Control Register 0	COMCTLO	00h
1301h	CAN0 Message Control Register 1	C0MCTL1	00h
1302h	CAN0 Message Control Register 2	C0MCTL2	00h
1303h	CAN0 Message Control Register 3	C0MCTL3	00h
1304h	CAN0 Message Control Register 4	C0MCTL4	00h
1305h	CAN0 Message Control Register 5	C0MCTL5	00h
1306h	CAN0 Message Control Register 6	C0MCTL6	00h
1307h	CAN0 Message Control Register 7	C0MCTL7	00h
1308h	CAN0 Message Control Register 8	C0MCTL8	00h
1309h	CAN0 Message Control Register 9	C0MCTL9	00h
130Ah	CAN0 Message Control Register 10	C0MCTL10	00h
130Bh	CAN0 Message Control Register 11	C0MCTL11	00h
130Ch	CAN0 Message Control Register 12	C0MCTL12	00h
130Dh	CANO Message Control Register 13	COMCTL13	00h
130Eh	CANO Message Control Register 14	COMCTL14	00h
130Fh	CANO Message Control Register 15	COMCTL15	00h
1310h	CANO Control Register	COCTLR	X000001b
1311h			XX0X0000b
1312h	CAN0 Status Register	COSTR	00h
1313h			X000001b
1314h	CAN0 Slot Status Register	COSSTR	00h
1315h			00h
1316h	CAN0 Interrupt Control Register	COICR	00h
1317h			00h
1318h	CAN0 Extended ID Register	C0IDR	00h
1319h	1 ~		00h
131Ah	CAN0 Configuration Register	COCONR	XXh
131Bh			XXh
131Ch	CAN0 Receive Error Count Register	CORECR	00h
131Dh	CANO Transmit Error Count Register	COTECR	00h
131Eh		00.201	
131Fh			
1320h			
1321h			
1322h			
1323h			
1324h			
1324h			
1325h			
1327h			
1328h			
1329h			
132Ah			
132Bh			
132Ch			
132Dh			
132Eh			
132Fh			
1330h			
1331h			
1332h			
1333h			
1334h			
1335h			
1336h			
1337h			
1338h			
1339h			
133Ah			
133Bh			
133Dh	<u> </u>		
133Dh			
133Eh 133Fh			

X: Undefined

NOTE:



A 1 1		<u> </u>	A.(
Address	Register	Symbol	After reset
1340h			
1341h		00150	200
1342h	CAN0 Acceptance Filter Support Register	COAFS	XXh
1343h			XXh
1344h			
1345h			
1346h			
1347h			
1348h			
1349h			
134Ah			
134Bh			
134Ch			
134Dh			
134Eh			
134Fh			
1350h			
1351h			
1352h			
1353h			ļ
1354h			
1355h			
1356h			
1357h			
1358h 1359h			
1359h 135Ah			
135An 135Bh			
135Bh 135Ch			
135Ch 135Dh			
135Dh 135Eh			
135Eh 135Fh	CANO Clock Soloct Pogistor	CCLKR	00h
135Fn 1360h	CAN0 Clock Select Register CAN0 Slot 0: Identifier/DLC	GOLINK	XXh
1360h			XXh
1361h			XXh
1362h			XXh
1364h			XXh
1365h			XXh
1366h	CAN0 Slot 0: Data Field	<u> </u>	XXh
1367h			XXh
1368h			XXh
1369h			XXh
136Ah			XXh
136Bh			XXh
136Ch			XXh
136Dh			XXh
136Eh	CAN0 Slot 0: Time Stamp		XXh
136Fh			XXh
1370h	CAN0 Slot 1: Identifier/DLC		XXh
1371h			XXh
1372h			XXh
1373h			XXh
1374h			XXh
1375h			XXh
1376h	CAN0 Slot 1: Data Field		XXh
1377h			XXh
1378h			XXh
1379h			XXh
137Ah			XXh
137Bh			XXh
137Ch			XXh
137Dh			XXh
137Eh	CAN0 Slot 1: Time Stamp		XXh
137Fh			XXh
Villadafiaad		L	•

Table 4.9SFR Information (9)(1)

X: Undefined

NOTE:

Table 4.10	SFR Information (10) ⁽¹⁾
------------	-------------------------------------

CAN0 Slot 2: Identifier/DLC		XXh XXh
		XXh
		XXh
CAN0 Slot 2: Data Field		XXh
		XXh
CAN0 Slot 2: Time Stamp		XXh
		XXh
CAN0 Slot 3: Identifier/DLC		XXh
		XXh
CAN0 Slot 3: Data Field		XXh
		XXh
CANO Slot 3: Time Stamp		XXh
oAno olor 5. Time olamp		XXh
CAND Slot 1: Identifier/DLC		XXh
SANO SIOL 4. Identifier/DEC		XXh
		XXh
2ANO Clat 4: Data Field		XXh
JAINU SIOL 4. Dala Fleid		
		XXh
CAINU Slot 4: Time Stamp		XXh
		XXh
CANU Slot 5: Identifier/DLC		XXh
		XXh
CAN0 Slot 5: Data Field		XXh
		XXh
CAN0 Slot 5: Time Stamp		XXh
		XXh
	CANO Slot 2: Data Field CANO Slot 2: Time Stamp CANO Slot 3: Identifier/DLC CANO Slot 3: Data Field CANO Slot 3: Time Stamp CANO Slot 4: Identifier/DLC CANO Slot 4: Data Field CANO Slot 4: Time Stamp CANO Slot 5: Identifier/DLC CANO Slot 5: Identifier/DLC CANO Slot 5: Data Field CANO Slot 5: Time Stamp	CANO Slot 2: Time Stamp CANO Slot 3: Identifier/DLC CANO Slot 3: Data Field CANO Slot 3: Time Stamp CANO Slot 4: Identifier/DLC CANO Slot 4: Identifier/DLC CANO Slot 4: Time Stamp CANO Slot 4: Time Stamp CANO Slot 5: Identifier/DLC CANO Slot 5: Identifier/DLC CANO Slot 5: Data Field

X: Undefined

NOTE:

Table 4.11	SFR Information (11) ⁽¹⁾
------------	-------------------------------------

Address	Desister	Sympol	After react
Address	Register	Symbol	After reset
13C0h 13C1h	CAN0 Slot 6: Identifier/DLC		XXh XXh
13C2h			XXh
13C3h			XXh
13C3h			XXh
13C4n 13C5h			XXh
	CAN0 Slot 6: Data Field		XXh
13C7h	CANU SIDI O. DAIA FIEIU		XXh
13C8h			XXh
13C9h			XXh
			XXh
13CAh 13CBh			XXh
13CCh			XXh
13CDh 13CEh	CAN0 Slot 6: Time Stamp		XXh XXh
13CFh	CANO SIOLO. TITLE Stattip		XXh
	CAN0 Slot 7: Identifier/DLC		XXh
13D0h	CANO SIOL 7. Identiliei/DEC		XXh
13D1h 13D2h			XXh
			XXh
13D3h 13D4h			XXh
13D4n 13D5h			XXh
	CAND Slot 7: Data Field		XXh XXh
13D6h 13D7h	CAN0 Slot 7: Data Field		XXh
13D7h 13D8h			XXh
13D9h			XXh
13D9h			XXh
13DAn 13DBh			XXh
13DBh 13DCh			XXh
13DDh			XXh
	CAN0 Slot 7: Time Stamp		XXh
13DEn 13DFh	CANO SIOL 7. TIME Stamp		XXh
13E0h	CAN0 Slot 8: Identifier/DLC		XXh
13E0h	CANU SIDI 6. IUEIIIIIIEI/DEC		XXh
13E11			XXh
13E3h			XXh
13E4h			XXh
13E4h			XXh
13E6h	CAN0 Slot 8: Data Field		XXh
13E7h	CANO SIDI O. Dala I leiu		XXh
13E8h			XXh
13E9h			XXh
13EAh			XXh
13EBh			XXh
13ECh			XXh XXh
13EDh	CANO Slot 9: Timo Stomp		
	CAN0 Slot 8: Time Stamp		XXh
13EFh	CAND Slot 0: Identifier/DLC		XXh XXh
	CAN0 Slot 9: Identifier/DLC		
13F1h			XXh
13F2h			XXh
13F3h			XXh
13F4h			XXh
13F5h	CAND Slot 9: Data Field		XXh XXh
	CAN0 Slot 9: Data Field		
13F7h			XXh
13F8h			XXh
13F9h			XXh
13FAh			XXh
13FBh			XXh
13FCh			XXh
13FDh			XXh
	CAN0 Slot 9: Time Stamp		XXh
13FFh			XXh

X: Undefined

NOTE:

Table 4.12	SFR Information (12) ⁽¹⁾
------------	-------------------------------------

			A. (1
Address	Register	Symbol	After reset
	CAN0 Slot 10: Identifier/DLC		XXh
1401h			XXh
1402h			XXh
1403h			XXh
1404h			XXh
1405h			XXh
	CAN0 Slot 10: Data Field		XXh
1407h			XXh
1408h			XXh
1409h			XXh
140Ah			XXh
140Bh			XXh
140Ch			XXh
140Dh			XXh
140Eh	CAN0 Slot 10: Time Stamp		XXh
140Fh			XXh
1410h	CAN0 Slot 11: Identifier/DLC		XXh
1411h			XXh
1412h			XXh
1413h			XXh
1414h			XXh
1415h			XXh
1416h	CAN0 Slot 11: Data Field		XXh
1417h			XXh
1418h			XXh
1419h			XXh
141Ah			XXh
141Bh			XXh
141Ch			XXh
141Dh			XXh
	CAN0 Slot 11: Time Stamp		XXh
141Fh			XXh
	CAN0 Slot 12: Identifier/DLC		XXh
1421h			XXh
1422h			XXh
1423h			XXh
1424h			XXh
1425h			XXh
	CAN0 Slot 12: Data Field		XXh
1427h			XXh
1428h			XXh
1429h			XXh
142Ah			XXh
142/01 142Bh			XXh
142Ch			XXh
1420h			XXh
	CAN0 Slot 12: Time Stamp		XXh
142En 142Fh			XXh
	CAN0 Slot 13: Identifier/DLC		XXh
14301 1431h			XXh
1431h 1432h			XXh
1433h 1434h			XXh XXh
1434h 1435h			
	CAN0 Slot 13: Data Field		XXh XXh
	UNINU SIUL IS. Dala FIEIU		
1437h			XXh
1438h			XXh
1439h			XXh
143Ah			XXh
143Bh			XXh
143Ch			XXh
143Dh			XXh
	CAN0 Slot 13: Time Stamp		XXh
143Fh			XXh

X: Undefined NOTE:

Table 4.13	SFR Information (13) ⁽¹⁾
------------	-------------------------------------

Address	Register	Symbol	After reset
1440h	CAN0 Slot 14: Identifier/DLC		XXh
1441h			XXh
1442h			XXh
1443h			XXh
1444h			XXh
1445h			XXh
1446h	CAN0 Slot 14: Data Field		XXh
1447h			XXh
1448h			XXh
1449h			XXh
144Ah			XXh
144Bh			XXh
144Ch			XXh
144Dh			XXh
144Eh	CAN0 Slot 14: Time Stamp		XXh
144Fh			XXh
1450h	CAN0 Slot 15: Identifier/DLC		XXh
1451h			XXh
1452h	1		XXh
1453h	1		XXh
1454h	1		XXh
1455h	1		XXh
1456h	CAN0 Slot 15: Data Field		XXh
1457h			XXh
1458h			XXh
1459h			XXh
145Ah			XXh
145Bh			XXh
145Ch			XXh
145Dh	4		XXh
145Eh	CAN0 Slot 15: Time Stamp		XXh
145Fh			XXh
1460h	CAN0 Global Mask Register	COGMR	XXh
1461h			XXh
1462h			XXh
1463h			XXh
1464h			XXh
1465h	1		XXh
1466h	CAN0 Local Mask A Register	COLMAR	XXh
1467h	1 [~]		XXh
1468h	1		XXh
1469h	1		XXh
146Ah	1		XXh
146Bh	1		XXh
146Ch	CAN0 Local Mask B Register	COLMBR	XXh
146Dh	Ĭ		XXh
146Eh	1		XXh
146Fh	1		XXh
1470h	1		XXh
1471h	1		XXh
1472h			
1473h			
1474h			
1475h			
			L
FFFFh	Option Function Select Register	OFS	(Note 2)

X: Undefined

NOTES:

The blank regions are reserved. Do not access locations in these regions.
 The OFS register cannot be changed by a program. Use a flash programmer to write to it.

5. Electrical Characteristics

Table 5.1	Absolute	Maximum	Ratings
-----------	----------	---------	---------

Symbol	Parameter	Condition	Rated value	Unit
Vcc/AVcc	Supply voltage		-0.3 to 6.5	V
Vi	Input voltage		-0.3 to Vcc+0.3	V
Vo	Output voltage		-0.3 to Vcc+0.3	V
Pd	Power dissipation	$-40^{\circ}C \le Topr \le 85^{\circ}C$	300	mW
		$85^{\circ}C < Topr \le 125^{\circ}C$	125	mW
Topr	Operating ambient temperature		-40 to 85 (D, J version) / -40 to 125 (K version)	°C
Tstg	Storage temperature		-65 to 150	°C

 Table 5.2
 Recommended Operating Conditions

Cumbal	Parameter		Conditions		Unit		
Symbol	Parameter		Conditions	Min.	Тур.	Max.	Unit
Vcc/AVcc	Supply voltage			2.7	-	5.5	V
Vss/AVcc	Supply voltage			-	0	-	V
Vih	Input "H" voltage			0.8Vcc	-	Vcc	V
VIL	Input "L" voltage			0	-	0.2Vcc	V
IOH(sum)	Peak sum output "H" current	Sum of all Pins IOH (peak)		-	_	-60	mA
IOH(peak)	Peak output "H" current			-	-	-10	mA
IOH(avg)	Average output "H" current			-	-	-5	mA
IOL(sum)	Peak sum output "L" currents	Sum of all Pins IOL (peak)		-	_	60	mA
IOL(peak)	Peak output "L" currents			-	-	10	mA
IOL(avg)	Average output "L" current			-	-	5	mA
f(XIN)	XIN clock input oscillation fr	equency	$\begin{array}{l} 3.0 \ V \leq Vcc \leq 5.5 \ V \\ -40^{\circ}C \leq Topr \leq 85^{\circ}C \end{array}$	0	_	20	MHz
			$\begin{array}{l} 3.0 \ V \leq Vcc \leq 5.5 \ V \\ -40^{\circ}C \leq Topr \leq 125^{\circ}C \end{array}$	0	_	16	MHz
			$2.7~V \leq Vcc < 3.0~V$	0	-	10	MHz
-	System clock	OCD2 = 0 When XIN	$\begin{array}{l} 3.0 \ V \leq Vcc \leq 5.5 \ V \\ -40^{\circ}C \leq Topr \leq 85^{\circ}C \end{array}$	0	-	20	MHz
		clock is selected.	$\begin{array}{l} 3.0 \ V \leq Vcc \leq 5.5 \ V \\ -40^{\circ}C \leq Topr \leq 125^{\circ}C \end{array}$	0	_	16	MHz
			$2.7~\text{V} \leq \text{Vcc} < 3.0~\text{V}$	0	-	10	MHz
		OCD2 = 1 When on-chip oscillator clock is selected.	FRA01 = 0 When low-speed on- chip oscillator clock is selected.	_	125	_	kHz
			FRA01 = 1 When high-speed on- chip oscillator clock is selected. 3.0 V \leq Vcc \leq 5.5 V -40°C \leq Topr \leq 85°C	_	-	20	MHz
			FRA01 = 1 When high-speed on- chip oscillator clock is selected.	_	_	10	MHz

NOTES:

1. Vcc = 2.7 to 5.5 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.

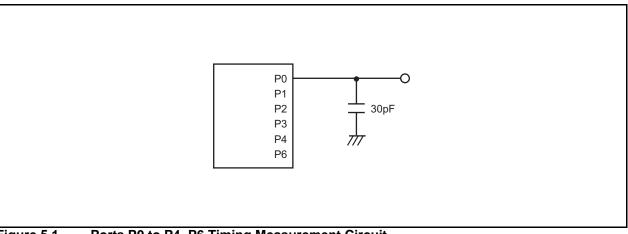
2. The average output current indicates the average value of current measured during 100 ms.



Cumb al	Parameter	Conditions		Unit			
Symbol	P	arameter	Conditions	Min.	Тур.	Max.	Unit
_	Resolution		Vref = AVCC	-	-	10	Bits
_	Absolute	10-bit mode	$\phi AD = 10 \text{ MHz}, \text{ Vref} = AVCC = 5.0 \text{ V}$	-	-	±3	LSB
	Accuracy	8-bit mode	$\phi AD = 10 \text{ MHz}, \text{ Vref} = AVCC = 5.0 \text{ V}$	-	-	±2	LSB
		10-bit mode	$\phi AD = 10 \text{ MHz}, \text{ Vref} = AVCC = 3.3 \text{ V}$	-	_	±5	LSB
		8-bit mode	$\phi AD = 10 \text{ MHz}, \text{ Vref} = AVCC = 3.3 \text{ V}$	-	_	±2	LSB
Rladder	Resistor ladder		Vref = AVCC	10	_	40	kΩ
tconv	Conversion time	10-bit mode	$\phi AD = 10 \text{ MHz}, \text{ Vref} = AVCC = 5.0 \text{ V}$	3.3	_	-	μs
		8-bit mode	$\phi AD = 10 \text{ MHz}, \text{ Vref} = AVCC = 5.0 \text{ V}$	2.8	_	-	μs
Vref	Reference voltage	9		2.7	_	AVcc	V
VIA	Analog input volta	uge ⁽²⁾		0	-	AVcc	V
-	A/D operating	Without sample & hold		0.25	-	10	MHz
	clock frequency	With sample & hold		1	-	10	MHz

	Table 5.3	A/D Converter Characteristics
--	-----------	-------------------------------

Vcc = AVcc = 2.7 to 5.5 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.
 When analog input voltage exceeds reference voltage, A/D conversion result is 3FFh in 10-bit mode, FFh in 8-bit mode.



Ports P0 to P4, P6 Timing Measurement Circuit Figure 5.1



Symbol	Parameter	Conditions	Standard				
Symbol		Conditions	Min.	. Typ. Max.		Unit	
-	Program/erase endurance ⁽²⁾	R8C/22 Group	100 ⁽³⁾	-	-	times	
		R8C/23 Group	1,000(3)	-	-	times	
-	Byte program time		-	50	400	μS	
-	Block erase time		-	0.4	9	S	
td(SR-SUS)	Time delay from suspend request until erase suspend		-	-	97 + CPU clock × 6 cycle	μS	
-	Interval from erase start/restart until following suspend request		650	-	-	μS	
-	Interval from program start/restart until following suspend request		0	-	-	ns	
-	Time from suspend until program/erase restart		-	-	3 + CPU clock × 4 cycle	μS	
-	Program, erase voltage		2.7	-	5.5	V	
-	Read voltage		2.7	-	5.5	V	
-	Program, erase temperature		0	-	60	°C	
-	Data hold time ⁽⁷⁾	Ambient temperature = 55°C	20	-	-	year	

 Table 5.4
 Flash Memory (Program ROM) Electrical Characteristics

1. Vcc = 2.7 to 5.5 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.

2. Definition of programming/erasure endurance The programming and erasure endurance is defined on a per-block basis. If the programming and erasure endurance is n (n = 100 or 1,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one. However, the same address must not be programmed more than once per erase operation (overwriting prohibited).

3. Endurance to guarantee all electrical characteristics after program and erase (1 to Min. value can be guaranteed).

4. In a system that executes multiple programming operations, the actual erasure endurance can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.

5. If error occurs during block erase, attempt to execute the clear status register command, then the block erase command at least three times until the erase error does not occur.

- 6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
- 7. The data hold time includes time that the power supply is off or the clock is not supplied.



Cumbal	Parameter	Conditions		Unit		
Symbol	Parameter	Conditions		Тур.	Max.	Unit
-	Program/erase endurance ⁽²⁾		10,000 ⁽³⁾	-	-	times
_	Byte program time (Program/erase endurance ≤ 1,000 times)		-	50	400	μS
_	Byte program time (Program/erase endurance > 1,000 times)		_	65	-	μS
_	Block erase time (Program/erase endurance ≤ 1,000 times)		_	0.2	9	S
_	Block erase time (Program/erase endurance > 1,000 times)		-	0.3	-	S
td(SR-SUS)	Time delay from suspend request until erase suspend		_	-	97 + CPU clock × 6 cycle	μS
_	Interval from erase start/restart until following suspend request		650	-	-	μS
_	Interval from program start/restart until following suspend request		0	-	_	ns
_	Time from suspend until program/erase restart		_	-	3 + CPU clock × 4 cycle	μS
-	Program, erase voltage		2.7	-	5.5	V
-	Read voltage		2.7	-	5.5	V
-	Program, erase temperature		-40	-	85(8)	°C
-	Data hold time ⁽⁹⁾	Ambient temperature = 55°C	20	-	-	year

Table 5.5	Flash Memory (Data Flash Block A, Block B) Electrical Characteristics ⁽⁴⁾
-----------	--

1. Vcc = 2.7 to 5.5 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.

2. Definition of programming/erasure endurance

The programming and erasure endurance is defined on a per-block basis.

If the programming and erasure endurance is n (n = 10,000), each block can be erased n times.

For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one. However, the same address must not be programmed more than once per erase operation (overwriting prohibited).

- 3. Minimum endurance to guarantee all electrical characteristics after program and erase (1 to Min. value can be guaranteed).
- 4. Standard of block A and block B when program and erase endurance exceeds 1,000 times. Byte program time to 1,000 times are the same as that in program ROM.
- 5. In a system that executes multiple programming operations, the actual erasure endurance can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. In addition, averaging the erasure endurance between blocks A and B can further reduce the actual erasure endurance. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.

6. If error occurs during block erase, attempt to execute the clear status register command, then the block erase command at least three times until the erase error does not occur.

7. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.

8. 125°C for K version.

9. The data hold time includes time that the power supply is off or the clock is not supplied.

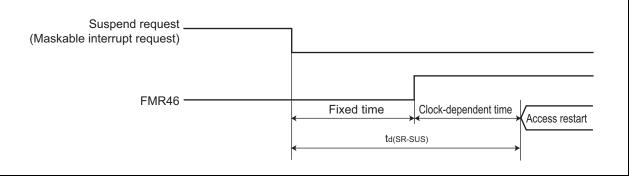


Figure 5.2 Time delay until Suspend

Table 5.6 Voltage Detection 1 Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
Symbol	Falalletei	Condition	Min.	Тур.	Max.	Offic
Vdet1	Voltage detection level ^(3, 4)		2.70	2.85	3.00	V
td(Vdet1-A)	Voltage monitor 1 reset generation time ⁽⁵⁾		-	40	200	μS
-	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	-	0.6	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽²⁾		-	-	100	μS
Vccmin	MCU operating voltage minimum value		2.70	-	-	V

NOTES:

1. The measurement condition is Vcc = 2.7 V to 5.5 V and Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version).

2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2

register to 0. 3. Hold Vdet2 > Vdet1.

4. This parameter shows the voltage detection level when the power supply drops. The voltage detection level when the power supply rises is higher than the voltage detection level when the power supply drops by approximately 0.1 V.

5. Time until the voltage monitor 1 reset is generated after the voltage passes V_{det1} when Vcc falls. When using the digital filter, its sampling time is added to td(Vdet1-A). When using the voltage monitor 1 reset, maintain this time until Vcc = 2.0 V after the voltage passes V_{det1} when the power supply falls.

Table 5.7 Voltage Detection 2 Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
Symbol	Falametei	Condition	Min.	Тур.	Max.	Unit
Vdet2	Voltage detection level ⁽⁴⁾		3.3	3.6	3.9	V
td(Vdet2-A)	Voltage monitor 2 reset/interrupt request generation time ^(2, 5)		-	40	200	μS
-	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0V	-	0.6	-	μA
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		-	-	100	μS

NOTES:

1. The measurement condition is Vcc = 2.7 V to 5.5 V and Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version).

2. Time until the voltage monitor 2 reset/interrupt request is generated since the voltage passes Vdet2.

3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.

4. Hold Vdet2 > Vdet1.

5. When using the digital filter, its sampling time is added to td(Vdet2-A). When using the voltage monitor 2 reset, maintain this time until Vcc = 2.0 V after the voltage passes Vdet2 when the power supply falls.



Symbol	Parameter	Condition	Standard			Unit
			Min.	Тур.	Max.	
Vpor1	Power-on reset valid voltage ⁽⁴⁾		-	-	0.1	V
Vpor2	Power-on reset or voltage monitor 1 valid voltage		0	-	Vdet1	V
trth	External power Vcc rise gradient	$Vcc \le 3.6 V$	20(2)	-	-	mV/msec
		Vcc > 3.6 V	20(2)	-	2,000	mV/msec

Table 5.8 Power-on Reset Circuit, Voltage Monitor 1 Reset Circuit Electrical Characteristics⁽³⁾

NOTES:

- 1. Topr = -40° C to 85° C (D, J version) / -40° C to 125° C (K version), unless otherwise specified.
- 2. This condition (the minimum value of external power Vcc rise gradient) does not apply if $V_{por2} \ge 1.0$ V.
- 3. To use the power-on reset function, enable voltage monitor 1 reset by setting the LVD1ON bit in the OFS register to 0, the VW1C0 and VW1C6 bits in the VW1C register to 1 respectively, and the VCA26 bit in the VCA2 register to 1.
- 4. $t_{w(por1)}$ indicates the duration the external power Vcc must be held below the effective voltage (Vpor1) to enable a power on reset. When turning on the power for the first time, maintain tw(por1) for 30s or more if -20°C \leq Topr \leq 125°C, maintain tw(por1) for 3,000s or more if -40°C \leq Topr < -20°C.

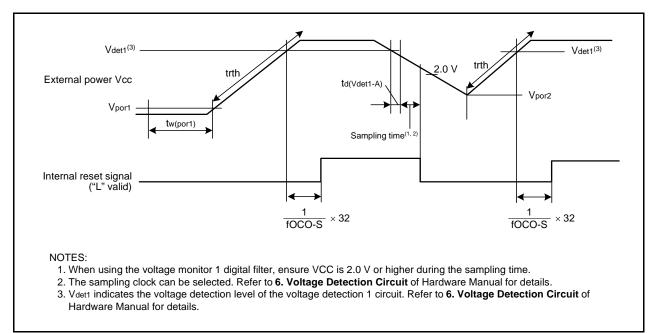


Figure 5.3 Power-on Reset Circuit Electrical Characteristics



Symbol	Parameter	Condition		1.1-+ 14		
			Min.	Тур.	Max.	Unit
fOCO40M	High-speed on-chip oscillator frequency temperature • supply voltage dependence	Vcc = 4.75 V to 5.25 V, $0^{\circ}C \le \text{Topr} \le 60^{\circ}C^{(2)}$	39.2	40	40.8	MHz
		Vcc = 3.0 V to 5.25 V , - $20^{\circ}\text{C} \le \text{Topr} \le 85^{\circ}\text{C}^{(2)}$	38.8	40	41.2	MHz
		$\label{eq:Vcc} \begin{array}{l} \mbox{Vcc} = 3.0 \mbox{ V to } 5.5 \mbox{ V,} \\ \mbox{-}40^{\circ}\mbox{C} \leq \mbox{Topr} \leq 85^{\circ}\mbox{C}^{(2)} \end{array}$	38.4	40	41.6	MHz
		Vcc = 3.0 V to 5.5 V, -40°C ≤ Topr ≤ 125°C ⁽²⁾	38.0	40	42.0	MHz
		Vcc = 2.7 V to 5.5 V, -40°C \leq Topr \leq 125°C ⁽²⁾	37.6	40	42.4	MHz
-	The value of the FRA1 register when the reset is deasserted		08h	40	F7h	-
_	High-speed on-chip oscillator adjustment range	Adjust the FRA1 register to -1 bit (the value when the reset is deasserted)	-	+ 0.3	-	MHz
-	Oscillation stability time		-	10	100	μs
-	Self power consumption when high-speed on-chip oscillator oscillating	Vcc = 5.0 V, Topr = 25°C	_	600	_	μΑ

Table 5.9 High-Speed On-Chip Oscillator Circuit Electrical Characteristics

1. Vcc = 2.7 V to 5.5 V, Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version), unless otherwise specified.

2. The standard value shows when the reset is deasserted for the FRA1 register.

Table 5.10 Low-Speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
			Min.	Тур.	Max.	Unit
fOCO-S	Low-speed on-chip oscillator frequency		40	125	250	kHz
-	Oscillation stability time		-	10	100	μS
-	Self power consumption when low-speed on-chip oscillator oscillating	Vcc = 5.0 V, Topr = 25°C	-	15	-	μA

NOTE:

1. Vcc = 2.7 V to 5.5 V, Topr = -40°C to 85°C (D, J version) / -40°C to 125°C (K version), unless otherwise specified.

Table 5.11 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Condition		Unit		
			Min.	Тур.	Max.	Unit
td(P-R)	Time for internal power supply stabilization during power-on ⁽²⁾		1	-	2000	μS
td(R-S)	STOP exit time ⁽³⁾		-	-	150	μS

NOTES:

1. The measurement condition is Vcc = 2.7 to 5.5 V and Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified.

2. Waiting time until the internal power supply generation circuit stabilizes during power-on.

3. Time until CPU clock supply starts since the interrupt is acknowledged to exit stop mode.



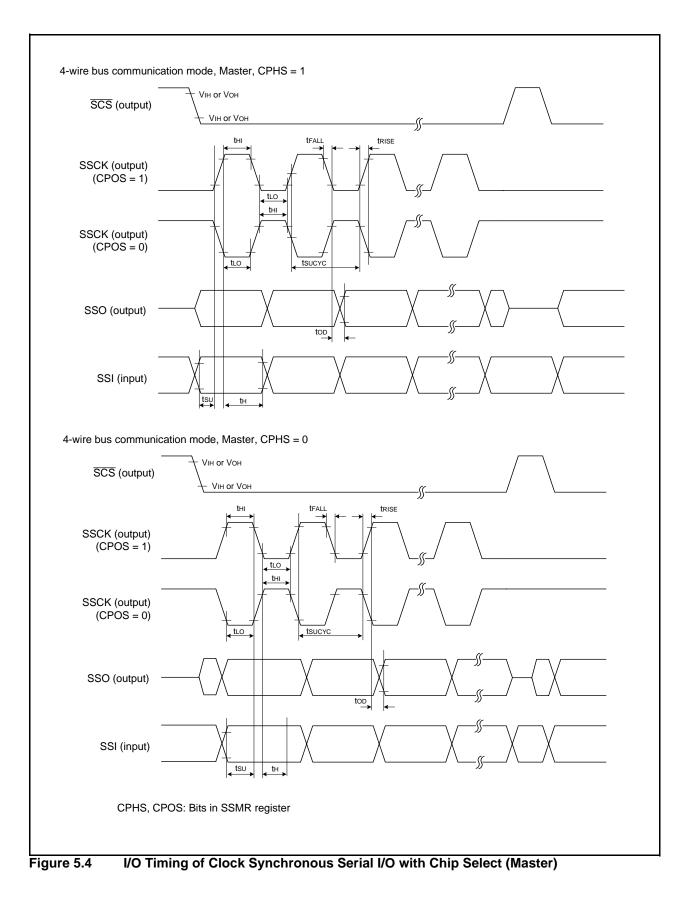
Cumbal	Parameter		Conditions		Unit		
Symbol			Conditions	Min.	Тур.	Max.	Unit
tsucyc	SSCK clock cycle time			4	-	-	tcyc ⁽²⁾
tнı	SSCK clock "H" width			0.4		0.6	tsucyc
tlo	SSCK clock "L" width			0.4	-	0.6	tsucyc
trise	SSCK clock rising time	Master		-	=	1	tCYC ⁽²⁾
		Slave		-	-	1	μS
tFALL	SSCK clock falling time	Master		-	-	1	tCYC ⁽²⁾
		Slave		-	-	1	μS
tsu	SSO, SSI data input setup ti	me		100	=	-	ns
tн	SSO, SSI data input hold tim	е		1	-	-	tCYC ⁽²⁾
tlead	SCS setup time	Slave		1tcyc + 50	-	-	ns
tlag	SCS hold time	Slave		1tcyc + 50	_	-	ns
top	SSO, SSI data output delay	time		-	-	1	tcyc ⁽²⁾
tSA	SSI slave access time			-		1tcyc + 100	ns
tor	SSI slave out open time			-	-	1tcyc + 100	ns

Table 5.12 Timing Requirements of Clock Synchronous Serial I/O with Chip Select⁽¹⁾

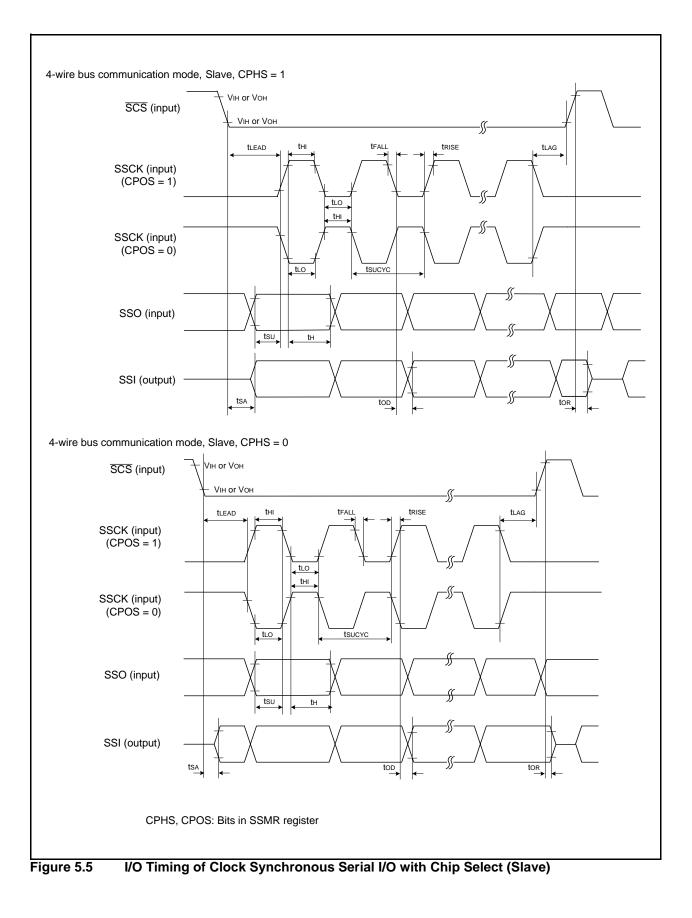
NOTES:

1. Vcc = 2.7 to 5.5 V, Vss = 0 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), unless otherwise specified. 2. 1tcyc = 1/f1(s)

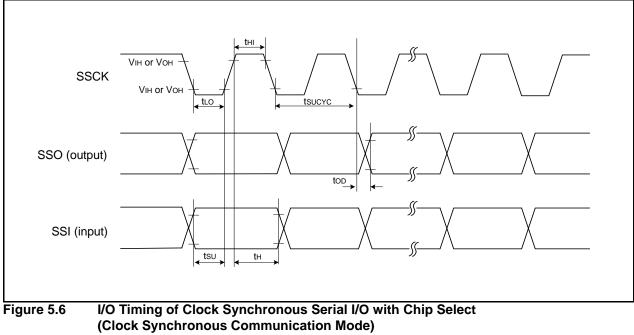








RENESAS



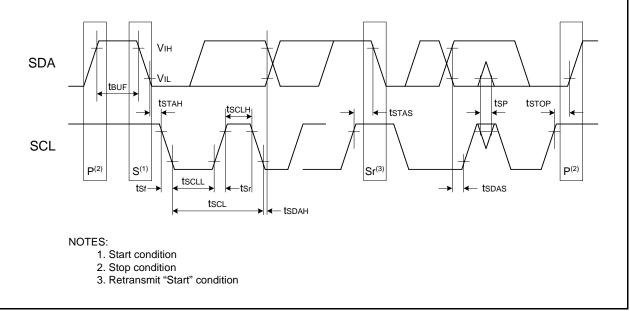


Symbol	Parameter	Conditions		Standard			
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
tscl	SCL input cycle time		12tcyc + 600 ⁽²⁾	-	-	ns	
tSCLH	SCL input "H" width		3tcyc + 300 ⁽²⁾	-	-	ns	
tSCLL	SCL input "L" width		5tcyc + 500 ⁽²⁾	_	-	ns	
tsf	SCL, SDA input falling time		-	-	300	ns	
tSP	SCL, SDA input spike pulse rejection time		-	-	1tcyc ⁽²⁾	ns	
t BUF	SDA input bus-free time		5tCYC ⁽²⁾	-	-	ns	
t STAH	Start condition input hole time		3tcyc ⁽²⁾	-	-	ns	
t STAS	Retransmit start condition input setup time		3tcyc ⁽²⁾	-	-	ns	
t STOP	Stop condition input setup time		3tcyc ⁽²⁾	-	-	ns	
tsoas	Data input setup time		1tcyc + 20 ⁽²⁾	_	-	ns	
t SDAH	Data input hold time		0	-	-	ns	

Table 5.13 Timing Requirements of I²C Bus Interface⁽¹⁾

NOTES:

1. Vcc = 2.7 to 5.5 V, Vss = 0V at Topr = -40 to 85° C (D, J version) / -40 to 125° C (K version), unless otherwise specified. 2. 1tcvc = 1/f1(s)





Symbol	Parameter		Cand	Condition		Standard			
Symbol	Pala	Falanielei				Тур.	Max.	Unit	
Vон	Output "H" Voltage	Except XOUT	Iон = -5 mA		Vcc - 2.0	-	Vcc	V	
			Іон = -200 μА		Vcc - 0.3	-	Vcc	V	
		XOUT	Drive capacity HIGH	Iон = -1 mA	Vcc - 2.0	-	Vcc	V	
			Drive capacity LOW	Іон = -500 μА	Vcc - 2.0	-	Vcc	V	
Vol	Output "L" Voltage	Except XOUT	lo∟ = 5 mA		-	-	2.0	V	
			IoL = 200 μA		-	-	0.45	V	
		XOUT	Drive capacity HIGH	IOL = 1 mA	-	-	2.0	V	
			Drive capacity LOW	IOL = 500 μA	-	-	2.0	V	
VT+-VT-	Hysteresis	INT0, INT1, INT2, INT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD1, RXD1, CLK0, SSI, SCL, SDA, SSO			0.1	0.5	-	V	
		RESET			0.1	1.0	-	V	
Ін	Input "H" current		VI = 5 V, Vcc = 5 V	,	-	_	5.0	μA	
lı∟	Input "L" current		VI = 0 V, Vcc = 5 V	1	-	-	-5.0	μA	
Rpullup	Pull-Up Resistance		VI = 0 V, Vcc = 5 V	1	30	50	167	kΩ	
Rfxin	Feedback Resistance	XIN			-	1.0	-	MΩ	
Vram	RAM Hold Voltage	•	During stop mode		2.0	-	-	V	

Table 5.14 Electrical Characteristics (1) [Vcc = 5 V]

NOTE:

1. Vcc = 4.2 to 5.5 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), f(XIN) = 20 MHz, unless otherwise specified.



Table 5.15Electrical Characteristics (2) [Vcc = 5 V]
(Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), Unless Otherwise Specified.)

Symbol	Paramotor		Condition		Standard	ł	Unit
Symbol	Parameter		Condition	Min.	Тур.	Max.	Unit
lcc	Power supply current (Vcc = 3.3 to 5.5 V) In single-chip mode, the output pins are	High-clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	12.5	25.0	mA
	open and other pins are Vss		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	10.0	20.0	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	6.5	_	mA
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	6.5	_	mA
			XIN = 16MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	5.0	-	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	3.5	-	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division	-	6.5	13.0	mA
			XIN clock off High-speed on-chip oscillator on fOCO= 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	3.2	-	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 FMR47 = 1	-	150	300	μA
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA20 = 0 VCA26 = VCA27 = 0	_	60	120	μΑ
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA20 = 0 VCA26 = VCA27 = 0	_	38	76	μA
		Stop mode Topr = 25°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	_	0.8	3.0	μA
		Stop mode Topr = 85°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	_	1.2	_	μA
		Stop mode Topr = 125°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	-	4.0	_	μA



Timing Requirements (Unless Otherwise Specified: Vcc = 5 V, Vss = 0 V at Topr = 25°C) [Vcc = 5 V]

Table 5.16 XIN Input

Symbol	Parameter	Standard Min. Max.	Unit	
Symbol	Falantelei	Min.	Max.	Unit
tc(XIN)	XIN input cycle time	50	-	ns
twh(XIN)	XIN input "H" width	25	-	ns
twl(XIN)	XIN input "L" width	25	-	ns

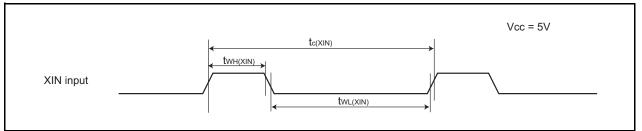


Figure 5.8 XIN Input Timing Diagram when VCC = 5 V

Table 5.17 TRAIO Input

Symbol	Parameter	Standard Min. Max. 100 - 40 -	Unit	
Symbol	Falanielei	Min.	Max.	Unit
tc(TRAIO)	TRAIO input cycle time	100	-	ns
twh(traio)	TRAIO input "H" width	40	-	ns
twl(traio)	TRAIO input "L" width	40	-	ns

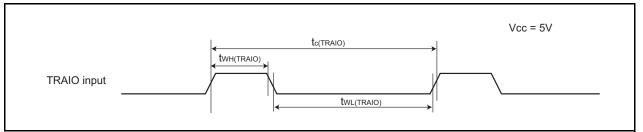


Figure 5.9 TRAIO Input Timing Diagram when Vcc = 5 V



Symbol	Parameter		Standard		
Symbol	Faidhelei	Min.	Max.	Unit	
tc(CK)	CLK0 input cycle time	200	-	ns	
tw(ckh)	CLK0 input "H" width	100	-	ns	
tW(CKL)	CLK0 input "L" width	100	-	ns	
td(C-Q)	TXDi output delay time	-	50	ns	
th(C-Q)	TXDi hold time	0	-	ns	
tsu(D-C)	RXDi input setup time	50	-	ns	
th(C-D)	RXDi input hold time	90	-	ns	

i = 0 or 1

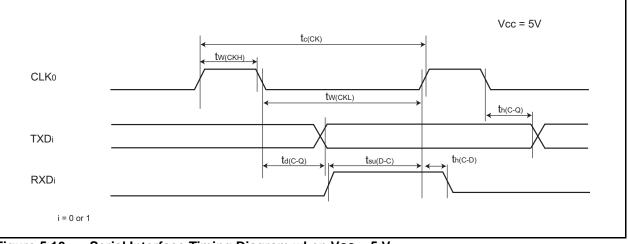


Figure 5.10 Serial Interface Timing Diagram when Vcc = 5 V

Table 5.19 External Interrupt INTi (i = 0 to 3) Input

Symbol	Parameter		Standard		
Symbol	Falameter	Min.	Max.	Unit	
tw(INH)	INTi input "H" width	250(1)	-	ns	
tw(INL)	INTi input "L" width	250 ⁽²⁾	-	ns	

NOTES:

1. When selecting the digital filter by the INTi input filter select bit, use the INTi input HIGH width to the greater value, either (1/digital filter clock frequency x 3) or the minimum value of standard.

2. When selecting the digital filter by the INTi input filter select bit, use the INTi input LOW width to the greater value, either (1/digital filter clock frequency x 3) or the minimum value of standard.

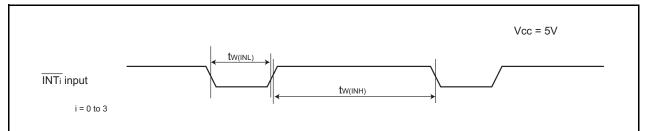


Figure 5.11 External Interrupt INTi Input Timing Diagram when Vcc = 5 V (i = 0 to 3)

Symbol	Paran	aatar	Condi	tion	S	tandard		Unit
Symbol	Falali	leter	Condition		Min. Typ. Ma		Max.	Unit
Vон	Output "H" voltage	Except XOUT	Iон = -1 mA		Vcc - 0.5	-	Vcc	V
		XOUT	Drive capacity HIGH	Iон = -0.1 mA	Vcc - 0.5	-	Vcc	V
			Drive capacity LOW	Іон = -50 μА	Vcc - 0.5	-	Vcc	V
Vol	Output "L" voltage	Except XOUT	IoL = 1 mA	•	-	I	0.5	V
		XOUT	Drive capacity HIGH	IOL = 0.1 mA	-	-	0.5	V
			Drive capacity LOW	ΙΟL = 50 μΑ	-	-	- 0.5	V
VT+-VT-	Hysteresis	INT0, INT1, INT2, INT3, KI0, KI1, KI2, KI3, TRAIO, RXD0, RXD1, CLK0, SSI, SCL, SDA, SSO			0.1	0.3	-	V
		RESET			0.1	0.4	-	V
Ін	Input "H" current		VI = 3 V, Vcc = 3 V		-	-	4.0	μA
lı∟	Input "L" current		VI = 0 V, Vcc = 3 V		-	-	-4.0	μA
Rpullup	Pull-up resistance		VI = 0 V, Vcc = 3 V		66	160	500	kΩ
Rfxin	Feedback resistance	XIN			-	3.0	-	MΩ
Vram	RAM hold voltage	•	During stop mode		2.0	-	-	V

Table 5.20	Electrical Characteristics (3) [Vcc = 3 V]

NOTE: 1. Vcc = 2.7 to 3.3 V at Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), f(XIN) = 10 MHz, unless otherwise specified.



Table 5.21Electrical Characteristics (4) [Vcc = 3 V]
(Topr = -40 to 85°C (D, J version) / -40 to 125°C (K version), Unless Otherwise Specified.)

Symbol	Parameter		Condition		Standard	ł	Unit
Symbol				Min.	Тур.	Max.	
Icc	Power supply current (Vcc = 2.7 to 3.3 V) In single-chip mode, the output pins are	High-clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	11.5	23.0	mA
	open and other pins are Vss		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	9.5	19.0	mA
		XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	6.0	12.0	mA	
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	5.5	-	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	4.5	-	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	3.0	-	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division	-	6.3	12.6	mA
			XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	3.1	-	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 FMR47 = 1	_	145	290	μA
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA20 = 0 VCA26 = VCA27 = 0	_	56	112	μΑ
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA20 = 0 VCA26 = VCA27 = 0	_	35	70	μA
		Stop mode Topr = 25°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	-	0.7	3.0	μΑ
		Stop mode Topr = 85°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	-	1.1	-	μΑ
		Stop mode Topr = 125°C	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA26 = VCA27 = 0	_	3.8	-	μΑ



Timing Requirements (Unless Otherwise Specified: Vcc = 3 V, Vss = 0V at Topr = 25°C) [Vcc = 3 V]

Table 5.22 XIN Input

Symbol	Parameter		Standard	
Symbol			Max.	Unit
tc(XIN)	XIN input cycle time	-	ns	
twh(xin)	XIN input "H" width 40 -			
twl(XIN)	XIN input "L" width 40 –			

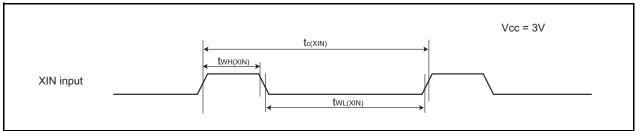


Figure 5.12 XIN Input Timing Diagram when VCC = 3 V

Table 5.23 TRAIO Input

Symbol	Parameter		Standard	
			Max.	Unit
tc(TRAIO)	TRAIO input Cycle time	300	-	ns
twh(traio)	TRAIO input "H" width	-	ns	
twl(traio)	TRAIO input "L" width	-	ns	

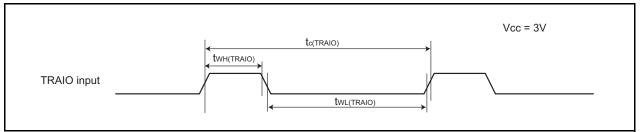


Figure 5.13 TRAIO Input Timing Diagram when Vcc = 3 V

Symbol	Parameter	Star	Unit	
	Falameter	Min.	Max.	Offic
tc(CK)	CLK0 input cycle time	300	-	ns
tW(CKH)	CLK0 input "H" width	150	-	ns
tW(CKL)	CLK0 input "L" width	150	-	ns
td(C-Q)	TXDi output delay time	80	ns	
th(C-Q)	TXDi hold time 0 -			
tsu(D-C)	RXDi input setup time 70 -			
th(C-D)	RXDi input hold time 90 –			

i = 0 or 1

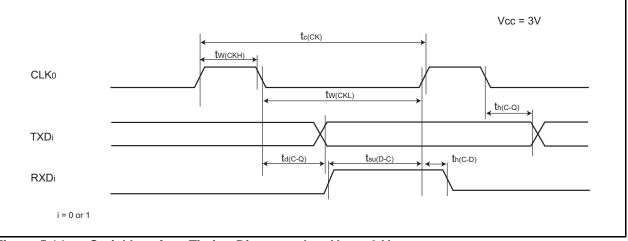


Figure 5.14 Serial Interface Timing Diagram when Vcc = 3 V

Table 5.25 External Interrupt INTi (i = 0 to 3) Input

Symbol	Parameter		Standard	
Symbol	Falanielei	Min.	Max.	Unit
tw(INH)	INTi input "H" width	380(1)	-	ns
tw(INL)	INTi input "L" width	380 ⁽²⁾	-	ns

NOTES:

1. When selecting the digital filter by the INTi input filter select bit, use the INTi input HIGH width to the greater value, either (1/digital filter clock frequency x 3) or the minimum value of standard.

2. When selecting the digital filter by the INTi input filter select bit, use the INTi input LOW width to the greater value, either (1/digital filter clock frequency x 3) or the minimum value of standard.

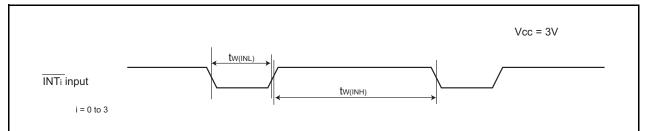
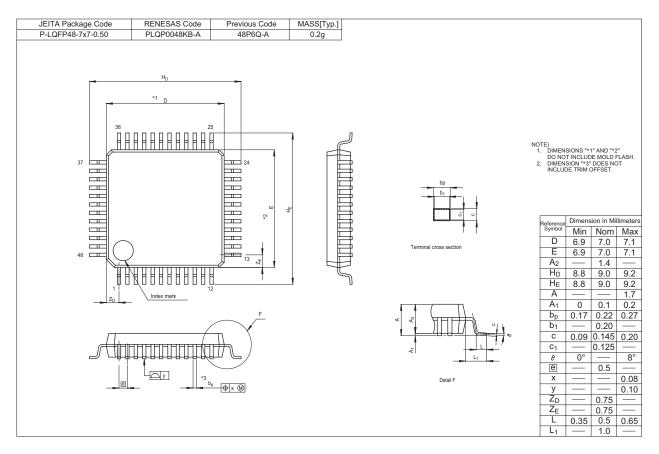


Figure 5.15 External Interrupt INTi Input Timing Diagram when Vcc = 3 V (i = 0 to 3)

Package Dimensions

Diagrams showing the latest package dimensions and mounting information are available in the "Packages" section of the Renesas Technology website.





REVISION HISTORY

R8C/22 Group, R8C/23 Group Datasheet

Pay Data			Description		
Rev.	Date	Page	Summary		
0.10	Mar 08, 2005	_	First Edition issued		
0.20	Sep 29, 2005	_	Words standardized - Clock synchronous serial interface → Clock synchronous serial I/O - Chip-select clock synchronous interface(SSU) → Clock synchronous serial I/O with chip select - I ² C bus interface(IIC) → I ² C bus interface		
		2, 3	 Table1.1 R8C/22 Group Performance, Table1.2 R8C/23 Group Performance Serial Interface revised: Clock Synchronous Serial Interface: 1 channel I²C bus Interface (3), Clock synchronous serial I/O with chip select Power-On Reset Circuit added Power Consumption value determined 		
		5, 6	Table 1.3 Product Information of R8C/22 Group, Table 1.4 Product Information of R8C/23 Group Date revised.		
		7	Figure 1.4 Pin Assignment Pin name revised: - P3_5/SSCK(/SCL) \rightarrow P3_5/SCL/SSCK - P3_4/SCS(/SDA) \rightarrow P3_4/SDA /SCS - VSS \rightarrow VSS/AVSS - VCC \rightarrow VCC/AVCC - P1_5/RXD0/(TRAIO/INT1) \rightarrow P1_5/RXD0/(TRAIO)/(INT1) - P6_6/INT2/(TXD1) \rightarrow P6_6/INT2/TXD1 - P6_7/INT3/(RXD1) \rightarrow P6_7/INT3/RXD1 - NOTE2 added		
		8	Table 1.5 Pin Description - Analog Power Supply Input: line added - I ² C Bus Interface (IIC) \rightarrow I ² C Bus Interface - SSU \rightarrow Clock Synchronous Serial I/O with Chip Select		
		9	Table 1.6 Pin Name Information by Pin Number revised - Pin Number 1: (SCL) \rightarrow SCL - Pin Number 2: (SDA) \rightarrow SDA - Pin Number 9: VSS \rightarrow VSS/AVSS - Pin Number 11: VCC \rightarrow VCC/AVCC - Pin Number 26: (TXD1) \rightarrow TXD1 - Pin Number 27: (RXD1) \rightarrow RXD1		
		15	Table 4.1 SFR Information (1) revised - 0013h: XXXXX00b \rightarrow 00h		
		17	Table 4.3 SFR Information (3) revised - 00BCh: 0000X000b → 00h/0000X000b		
		18	Table 4.4 SFR Information (4) revised - 00D6h: 00000XXXb → 00h - 00F5h: UART1 Function Select Register added		
		19	Table 4.5 SFR Information (5) revised - 0104h: TRATR \rightarrow TRA		

REVISION HISTORY

R8C/22 Group, R8C/23 Group Datasheet

	Data		Description
Rev.	Date	Page	Summary
0.20	Sep 29, 2005	20	Table 4.6 SFR Information (6) revised - 0145h: POCR0 \rightarrow TRDPOCR0 - 0146h, 0147h: TRDCNT0 \rightarrow TRD0 - 0148h, 0149h: GRA0 \rightarrow TRDGRA0 - 014Ah, 014Bh: GRB0 \rightarrow TRDGRB0 - 014Ch, 014Dh: GRC0 \rightarrow TRDGRD0 - 014Eh, 014Fh: GRD0 \rightarrow TRDGRD0 - 0155h: POCR1 -> TRDPOCR1 - 0156h, 0157h: TRDCNT1 \rightarrow TRD1 - 0156h, 0159h: GRA1 \rightarrow TRDGRA1 - 015Ah, 015Bh: GRB1 \rightarrow TRDGRB1 - 015Ch, 015Dh: GRC1 \rightarrow TRDGRD1
		28	5. Electrical Characteristics added
1.00	Oct 27, 2006	All pages 2	"Preliminary" and "Under development" deleted Table 1.1 Functions and Specifications for R8C/22 Group revised. NOTE1 deleted.
		3	Table 1.2 Functions and Specifications for R8C/23 Group revised. NOTE1 deleted.
		5	Table 1.3 Product Information for R8C/22 Group; "R5F2122AJFP (D)", "R5F2122CJFP (D)", "R5F2122AKFP (D)", "R5F2122CKFP (D)", and NOTE added. Figure 1.2 Type Number, Memory Size, and Package of R8C/22 Group; "A: 96 KB" and "C: 128 KB" added.
		6	Table 1.4 Product Information for R8C/23 Group; "R5F2123AJFP (D)", "R5F2123CJFP (D)", "R5F2123AKFP (D)", "R5F2123CKFP (D)", and NOTE added. Figure 1.3 Type Number, Memory Size, and Package of R8C/23 Group; "A: 96 KB" and "C: 128 KB" added.
		13	Figure 3.1 Memory Map of R8C/22 Group revised.
		14	Figure 3.2 Memory Map of R8C/23 Group revised.
		15	Table 4.1 SFR Information (1) ⁽¹⁾ ; NOTE8; "The CSPROINI bit in the OFS register is set to 0." \rightarrow "The CSPROINI bit in the OFS register is 0." revised.
		28	Table 5.1 Absolute Maximum Ratings; Power dissipation revised. Table 5.2 Recommended Operating Conditions; System clock revised.
		33 34	Table 5.8 Voltage Monitor 1 Reset Circuit Electrical Characteristics → Table 5.8 Power-on Reset Circuit, Voltage Monitor 1 Reset Circuit Electrical Characteristics ⁽¹⁾ replaced. Table 5.8 revised. NOTE3 added. Table 5.9 Power-on Reset Circuit Electrical Characteristics deleted. Figure 5.3 Power-on Reset Circuit Electrical Characteristics revised. Table 5.10 High-Speed On-Chip Oscillator Circuit Electrical
			Characteristics \rightarrow Table 5.9 High-Speed On-Chip Oscillator Circuit Electrical Characteristics revised.

REVISION HISTORY

R8C/22 Group, R8C/23 Group Datasheet

D	Data		Description
Rev.	Date	Page	Summary
1.00	Oct 27, 2006	40	Table 5.15 Electrical Characteristics (1) [VCC = 5 V] \rightarrow Table 5.14 Electrical Characteristics (1) [VCC = 5 V] revised. RAM Hold Voltage, Min.; "1.8" \rightarrow "2.0" corrected.
		41	Table 5.16 Electrical Characteristics (2) [Vcc = 5 V] \rightarrow Table 5.15 Electrical Characteristics (2) [Vcc = 5 V] revised. Wait mode revised.
		44	Table 5.21 Electrical Characteristics (3) [VCC = 3 V \rightarrow Table 5.20 Electrical Characteristics (3) [VCC = 3 V] revised. RAM hold voltage, Min.; "1.8" \rightarrow "2.0" corrected.
		45	Table 5.22 Electrical Characteristics (4) [Vcc = 3 V] \rightarrow Table 5.21 Electrical Characteristics (4) [Vcc = 3 V] revised. Wait mode revised.
1.10	Mar 16, 2007	_	D version products added. Relevant descriptions revised because of expanding products - Table 1.1 to 1.4 revised. - Figure 1.2 and 1.3 revised. - Figure 3.1 and 3.2 revised. - Table 5.1 to 5.15 revised. - Table 5.20 and 5.21 revised.
		15	Table 4.1 revised; 000Ah: "00XXX000b" → "00h", 000Fh: "00011111b" → "00X11111b"
		42	Table 5.17 and Figure 5.9 revised; "INT1 input" deleted
		43	Table 5.19 and Figure 5.11 revised; "i = 0, 2, 3" \rightarrow "i = 0 to 3"
		46	Table 5.23 and Figure 5.13 revised; "INT1 input" deleted
		47	Table 5.25 and Figure 5.15 revised; "i = 0, 2, 3" \rightarrow "i = 0 to 3"
2.00	Aug 20, 2008	-	"RENESAS TECHNICAL UPDATE" reflected: TN-16C-A172A/E
		5, 6	Table 1.3, Table 1.4 revised Figure 1.2, Figure 1.3; ROM number "XXX" added
		13, 14	Figure 3.1, Figure 3.2; "Expanding area" deleted
		23	Table 4.9 135Fh Address "XXXX0000b" \rightarrow "00h"
		28	Table 5.2; NOTE2 revised
		30	Table 5.4; NOTE2 and NOTE4 revised
		31	Table 5.5; NOTE2 and NOTE5 revised
		32	Table 5.6; "td(Vdet1-A)" added, NOTE5 added Table 5.7; "td(Vdet2-A)" and NOTE2 revised, NOTE5 added
		33	Table 5.8; "trth" and NOTE2 revised, Figure 5.3 revised

All trademarks and registered trademarks are the property of their respective owners.

RenesasTechnology Corp. sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

- Benesas lechnology Corp. sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
 Nice
 This document is provided for reference purposes only so that Renesas customers may select the appropriate Renesas products for their use. Renesas neither makes warranties or representations with respect to the accuracy or completeness of the information in this document.
 This document is provided for reference purposes only so that Renesas customers may select the appropriate Renesas products for the true. Renesas neither makes document.
 This document is provided for reference purposes only so that Renesas customers may select the appropriate Renesas products for the true of any information in this document.
 This document is provided that, diagrams, charts, programs, algorithms, and application scul as the development of weapons of mass and regulations.
 Al information included in this document, such as product data, diagrams, charts, programs, algorithms, and application circuit examples, is current as of the date this document, where the set as and encluded in this document.
 Post and regulations, and proceedures required by such laws and regulations.
 Al information included in this document, such as product data, diagrams, charts, programs, algorithms, and application circuit examples, is current as of the date this document, but Renesas assumes no liability whatsoever for any damages incurred as a set of the result of errors or omissions in the information in this document. Dut Renesas are such as a such reasonable care in compiling the information on this document. Dut Renesas as products are the tedes of the subscription of the process assumes no liability whatsoever for any damages incurred as a state of other such as product as the set of the such association and regulations.
 When using or otherwise regulations and process are document, you should evaluate the information in light of the tot



RENESAS SALES OFFICES

Refer to "http://www.renesas.com/en/network" for the latest and detailed information.

Renesas Technology America, Inc

450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K. Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology (Shanghai) Co., Ltd. Unit 204, 205, AZIACenter, No.1233 Lujiazui Ring Rd, Pudong District, Shanghai, China 200120 Tel: <86> (21) 5877-1818, Fax: <86> (21) 6887-7858/7898

Renesas Technology Hong Kong Ltd. 7th Floor, North Tower, World Finance Centre, Harbour City, Canton Road, Tsimshatsui, Kowloon, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2377-3473

Renesas Technology Taiwan Co., Ltd. 10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 3518-3399

Renesas Technology Singapore Pte. Ltd.

1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd. Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145

Renesas Technology Malaysia Sdn. Bhd Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510

http://www.renesas.com

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for 16-bit Microcontrollers - MCU category:

Click to view products by Renesas manufacturer:

Other Similar products are found below :

M30302FCPFP#U3 MB90F036APMC-GSE1 MB90F428GCPFR-GSE1 MB96F683RBPMC-GSAE1 R5F10MMGDFB#30 R5F111PGGFB#30 R5F117BCGNA#20 DF3026XBL25V DF36014GFTV DF36014GFXV DF36034GFPV R5F11B7EANA#U0 R5F21172DSP#U0 MB90092PF-G-BNDE1 MB90F335APMC1-G-SPE1 MB90F345CAPFR-GSE1 MB90F568PMCR-GE1 MB96F395RSAPMC-GSE2 DF36024GFXV UPD78F1018F1-BA4-A MB96F018RBPMC-GSE1 MB90F867ASPFR-GE1 M30290FCHP#U3A DF2239FA20IV R5F117BCGFP#30 LC88F58B0AU-SQFPH MB90F548GPF-GE1 MB90214PF-GT-310-BND-AE1 MB90F342CESPQC-GSE2 MB90F428GAPF-GSE1 ML620Q504H-NNNTBWBX S912ZVH128F2VLL UPD78F1500AGK-GAK-AX HD64F3337SF16V MB90F428GCPF-GSE1 MB90F342ESPMC-G-JNE1 MB90022PF-GS-358E1 MB96F395RWAPMC-GSE2 MB96395RSAPMC-GS-110E2 MB90F883CSPMC-GE1 S912ZVHY64F1CLL S912ZVHY64F1VLQ ST10F280 MB96F338RSAPMCR-GK5E2 CY90096PF-G-002-BND-ERE1 ML62Q1569-NNNGAZ0AX ML62Q1739-NNNGAZ0AX ML62Q1749-NNNGAZ0AX ML62Q1579-NNNGAZ0AX ML62Q1559-NNNGAZ0AX